Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product information in this catalog is as of October 2015. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact TAIYO YUDEN CO., LTD. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").

 It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may
- occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

MULTILAYER COMMON MODE CHOKE COILS(MC SERIES F TYPE)



REFLOW

■PARTS NUMBER

* Operating Temp.: -40~+85°C



△=Blank space

①Series name

Code	Series name
MCF	Multilayer common mode choke coil

②Dimensions

Code	Dimensions[mm]
0605	0.65 × 0.50
0806	0.85 × 0.65
1210	1.25 × 1.0
2010	2.0 × 1.0

3No. of Lines

Code	No. of Lines
2	2 lines
4	4 lines

4 Material

	Code	Material				
-	G	Defends investment				
	E	Refer to impedance curves for material differences				
	Н	for material differences				

5Nominal common impedance

Code (example)	Nominal common impedance[Ω]
120	12
900	90

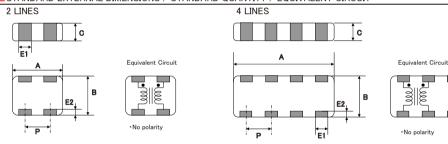
6 Packaging

Code Packaging					
	Code	Packaging			
	-T	Taping			

7Internal code

	Code	Internal code
	Δ	Standard

■ STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY / EQUIVALENT CIRCUIT



Туре	А	В	С	E1	E2	Р	Standard quantity [pcs] Taping
MCF0605	0.65 ± 0.05	0.50 ± 0.05	0.30 ± 0.05	0.15±0.1	0.12±0.1	0.40 ± 0.10	15000
1000 0000	(0.026 ± 0.002)	(0.020 ± 0.002)	(0.012 ± 0.002)	(0.006 ± 0.004)	(0.005 ± 0.004)	(0.016 ± 0.004)	13000
MCF0806	0.85 ± 0.05	0.65 ± 0.05	0.40 ± 0.05	0.27 ± 0.1	0.2 +0.05/-0.1	0.50 ± 0.10	10000
WCI 0000	(0.033 ± 0.002)	(0.026 ± 0.002)	(0.016 ± 0.002)	(0.011 ± 0.004)	(0.008 +0.002/-0.004)	(0.020 ± 0.004)	10000
MCF1210	1.0±0.15	1.25±0.15	0.55±0.1	0.3±0.1	0.2±0.1	0.55 ± 0.10	5000
MCF1210	(0.039 ± 0.006)	(0.049 ± 0.006)	(0.022 ± 0.004)	(0.012 ± 0.004)	(0.008 ± 0.004)	(0.022 ± 0.004)	3000
MCF2010	2.0±0.15	1.0±0.15	0.45±0.1	0.25 +0.15/-0.1	0.25±0.15	0.50 ± 0.10	4000
WICE 2010	(0.079 ± 0.006)	(0.039 ± 0.006)	(0.018 ± 0.004)	(0.010 +0.006/-0.004)	(0.010 ± 0.006)	(0.020 ± 0.004)	4000

Unit:mm(inch)

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MCF0605 type

WINOI GOOD LYPC	moi dodd type									
Parts number	EHS	No. of Lines	Common mode impedance $\left[\Omega ight]$	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage [V]	Insulation resistance $[M\Omega]$ (min.)		
MCF0605 2G120-T	RoHS	2	12±5	100	2.5	0.05	5	100		
MCF0605 2G350-T	RoHS	2	35±20%	100	6.5	0.05	5	100		
MCF0605 2E600-T	RoHS	2	60±25%	100	4.75	0.05	5	100		
MCF0605 2E900-T	RoHS	2	90±25%	100	3.9	0.05	5	100		

MCF0806 type

Parts number	EHS	No. of Lines	Common mode impedance $\left[\Omega ight]$	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage [V]	Insulation resistance $[M\Omega]$ (min.)
MCF0806 2G120-T	RoHS	2	12±5	100	2.5	0.13	5	100
MCF0806 2G470-T	RoHS	2	47±20%	100	4.0	0.10	5	100
MCF0806 2G900-T	RoHS	2	90±20%	100	5.0	0.10	5	100
MCF0806 2E300-T	RoHS	2	30±25%	100	1.5	0.15	5	100

MCF1210 type

Parts number	EHS	No. of Lines	Common mode impedance $\left[\Omega ight]$	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage [V]	Insulation resistance [MΩ] (min.)
MCF1210 2G400-T	RoHS	2	40±25%	100	2.5	0.10	5	100
MCF1210 2G900-T	RoHS	2	90±25%	100	4.5	0.10	5	100
MCF1210 2H900-T	RoHS	2	90±20%	100	2.5	0.15	5	100

MCF2010 type

	Parts number	EHS	No. of Lines	Common mode impedance $\left[\:\Omega\:\right]$	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage [V]	Insulation resistance $[M\Omega]$ (min.)
М	ICF2010 4G900-T	RoHS	4	90±25%	100	4.5	0.10	5	100

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Multilayer chip inductors Multilayer chip inductors for high frequency, Multilayer chip bead inductors Multilayer common mode choke coils (MC series F type) Metal Multilayer Chip Power Inductors (MCOILTM MC series)

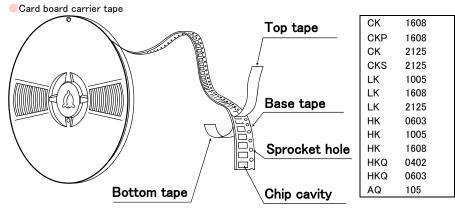
PACKAGING

1 Minimum Quantity

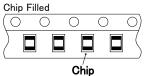
Tape & Reel Packaging			
Turna	Thickness	Standard Q	uantity [pcs]
Type	mm(inch)	Paper Tape	Embossed Tape
CK1608(0603)	0.8 (0.031)	4000	_
CK2125 (0805)	0.85(0.033)	4000	_
GN2123 (0003)	1.25(0.049)	_	2000
CK6313E(000E)	0.85(0.033)	4000	_
CKS2125 (0805)	1.25(0.049)	_	2000
CKP1608 (0603)	0.8 (0.031)	4000	_
CKP2012 (0805)	0.9 (0.035)	_	3000
CKP2016 (0806)	0.9 (0.035)	_	3000
	0.7 (0.028)	_	3000
CKP2520 (1008)	0.9 (0.035)	_	3000
	1.1 (0.043)	_	2000
NM2012 (0805)	0.9 (0.035)	_	3000
NIMOTOO (1000)	0.9 (0.035)	_	3000
NM2520(1008)	1.1 (0.043)	_	2000
LK1005 (0402)	0.5 (0.020)	10000	_
LK1608 (0603)	0.8 (0.031)	4000	_
11(0105(0005)	0.85(0.033)	4000	_
LK2125 (0805)	1.25(0.049)	_	2000
HK0603 (0201)	0.3 (0.012)	15000	_
HK1005 (0402)	0.5 (0.020)	10000	_
HK1608 (0603)	0.8 (0.031)	4000	_
(0.1.0.5 (0.0.0.5)	0.85(0.033)	_	4000
HK2125(0805)	1.0 (0.039)	_	3000
HKQ0402 (01005)	0.2 (0.008)	20000	40000
HKQ0603W(0201)	0.3 (0.012)	15000	_
HKQ0603C(0201)	0.3 (0.012)	15000	_
HKQ0603S(0201)	0.3 (0.012)	15000	_
HKQ0603U(0201)	0.3 (0.012)	15000	_
AQ105(0402)	0.5 (0.020)	10000	_
BK0402(01005)	0.2 (0.008)	20000	_
BK0603(0201)	0.3 (0.012)	15000	_
BK1005(0402)	0.5 (0.020)	10000	_
BKH0603(0201)	0.3 (0.012)	15000	_
BKH1005 (0402)	0.5 (0.020)	10000	_
BK1608(0603)	0.8 (0.031)	4000	_
	0.85(0.033)	4000	_
BK2125(0805)	1.25(0.049)	_	2000
BK2010(0804)	0.45(0.018)	4000	_
BK3216(1206)	0.8 (0.031)	_	4000
BKP0402 (01005)	0.2 (0.008)	20000	_
BKP0603 (0201)	0.3 (0.012)	15000	_
BKP1005 (0402)	0.5 (0.020)	10000	_
BKP1608 (0603)	0.8 (0.031)	4000	_
BKP2125 (0805)	0.85 (0.033)	4000	_
MCF0605 (0202)	0.3 (0.012)	15000	_
MCF0806 (0302)	0.4 (0.016)	_	10000
MCF1210(0504)	0.55 (0.022)	_	5000
MCF2010(0804)	0.45 (0.018)	_	4000
MCFE1608 (0603)	0.65(0.026)	4000	-
MCKK2012 (0805)	1.00(0.039)	-	3000
		1	·

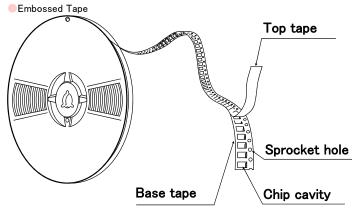
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2Taping material



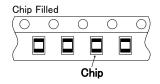
BK	0402	
BK	0603	
BK	1005	
BK	1608	
BK	2125	
BK	2010	
BKP	0402	
BKP	0603	
BKP	1005	
BKP	1608	
BKP	2125	
BKH	0603	
BKH	1005	
MCF	0605	
MC	1608	





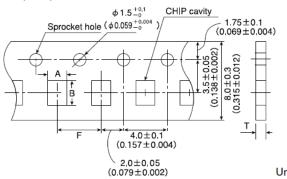
CK	2125
CKS	2125
CKP	2012
CKP	2016
CKP	2520
NM	2012
NM	2520
LK	2125
HKQ	0402
HK	2125

BK	2125	
BK	3216	
MCF	0806	
MCF	1210	
MCF	2010	
MC	2012	
	•	



3Taping Dimensions

Paper tape (8mm wide)



Unit: mm (inch)

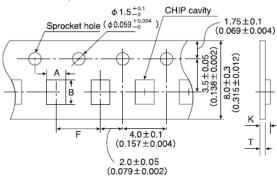
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	Thickness	Chip	cavity	Insertion Pitch	Tape Thickness
Туре	mm (inch)	A	В	F	Т
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CK1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		1.5±0.2	2.3±0.2	4.0±0.1	1.1max
CK2125(0805)	0.85(0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		1.5±0.2	2.3±0.2	4.0±0.1	1.1max
CKS2125(0805)	0.85(0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CKP1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		0.65±0.1	1.15±0.1	2.0±0.05	0.8max
LK1005 (0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
LK1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
11(0405(0005)	0.05(0.000)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
LK2125 (0805)	0.85(0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
	()	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HK0603(0201)	0.3 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
	()	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
HK1005(0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
LU(1000 (0000)	0.0 (0.004)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
HK1608 (0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
HKO0400 (0100E)	0.0 (0.000)	0.25±0.04	0.45±0.04	2.0±0.05	0.36max
HKQ0402 (01005)	0.2 (0.008)	(0.010 ± 0.002)	(0.018 ± 0.002)	(0.079 ± 0.002)	(0.014max)
LIKO0603W(0301)	0.2 (0.010)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603W(0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
HKO0603C (0301)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603C (0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
HKQ0603S(0201)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HNQ00033(0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
HKQ0603U(0201)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ00030 (0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
AQ105(0402)	0.5 (0.020)	0.75±0.1	1.15±0.1	2.0±0.05	0.8max
AQ100(0402)	0.0 (0.020)	(0.030 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
BK0402(01005)	0.2 (0.008)	0.25 ± 0.04	0.45 ± 0.04	2.0±0.05	0.36max
	0.2 (0.000)	(0.010 ± 0.002)	(0.018±0.002)	(0.079 ± 0.002)	(0.014max)
BK0603(0201)	0.3 (0.012)	0.40 ± 0.06	0.70±0.06	2.0±0.05	0.45max
	0.0 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
BK1005(0402)	0.5 (0.020)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
	0.0 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
BK1608(0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
	, ,	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157±0.004)	(0.043max)
BK2125(0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
	, ,	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
BK2010(0804)	0.45 (0.018)	1.2±0.1	2.17±0.1	4.0±0.1	0.8max
· · ·		(0.047±0.004)	(0.085 ± 0.004)	(0.157±0.004)	(0.031max)
BKP0402 (01005)	0.2 (0.008)	0.25 ± 0.04	0.45 ± 0.04	2.0±0.05	0.36max
		(0.010±0.002)	(0.018±0.002)	(0.079±0.002)	(0.014max)
BKP0603(0201)	0.3 (0.012)	0.40 ± 0.06	0.70 ± 0.06	2.0 ± 0.05	0.45max
		(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
BKP1005 (0402)	0.5 (0.020)	0.65 ± 0.1	1.15 ± 0.1	2.0±0.05	0.8max
	+	(0.026±0.004) 1.0±0.2	(0.045±0.004)	(0.079±0.002)	(0.031max)
BKP1608 (0603)	0.8 (0.031)	(0.039 ± 0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1	1.1max (0.043max)
		(0.039±0.008) 1.5±0.2	2.3±0.2	(0.157±0.004) 4.0±0.1	(0.043max) 1.1max
BKP2125 (0805)	0.85(0.033)	(0.059±0.008)	(0.091 ± 0.008)	4.0±0.1 (0.157±0.004)	(0.043max)
		0.40±0.06	0.70±0.06	2.0±0.05	0.45max
BKH0603(0201)	0.3 (0.012)	(0.40±0.06 (0.016±0.002)	(0.028±0.002)	(0.079±0.002)	0.45max (0.018max)
		0.016±0.002)	1.15±0.1		
BKH1005(0402)	0.5 (0.020)	(0.026±0.004)	(0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
		0.62±0.03	0.77±0.03	2.0±0.05	0.45max
MCF0605(0202)	0.3 (0.012)	(0.024±0.001)	(0.030 ± 0.001)	(0.079±0.002)	(0.018max)
		1.1±0.05	1.9±0.05	4.0±0.1	0.72max
MCFE1608(0603)	0.65(0.026)	(0.043 ± 0.002)	(0.075 ± 0.002)	(0.157 ± 0.004)	(0.028max)
	1	(0.040 ± 0.002)	(0.070 ± 0.002)	(0.107 ± 0.004)	Unit: mm (inch)

Unit: mm(inch)

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Embossed Tape (8mm wide)



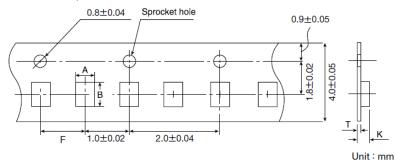
Unit: mm (inch)

T	Thickness	Chip	cavity	Insertion Pitch	Tape Th	nickness
Туре	mm(inch)	Α	В	F	K	Т
CK2125(0805)	1.25 (0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKS2125(0805)	1.25 (0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKP2012 (0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3 ± 0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
CKP2016 (0806)	0.9 (0.035)	1.8±0.1 (0.071±0.004)	2.2±0.1 (0.087±0.004)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.01)
	0.7 (0.028)				1.4 (0.055)	
CKP2520 (1008)	0.9 (0.035)	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
	1.1 (0.043)				1.7 (0.067)	
NM2012 (0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
NM2520(1008)	0.9 (0.035)	2.3±0.1	2.8±0.1	4.0±0.1	1.4 (0.055)	0.3
NM2320(1006)	1.1 (0.043)	(0.091 ± 0.004)	(0.110±0.004)	(0.157±0.004)	1.7 (0.067)	(0.012)
LK2125 (0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
LIK010E (000E)	0.85 (0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.5 (0.059)	0.3
HK2125 (0805)	1.0 (0.039)	(0.059 ± 0.008)	(0.091±0.008)	(0.157±0.004)	2.0 (0.079)	(0.012)
BK2125(0805)	1.25 (0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
BK3216(1206)	0.8(0.031)	1.9±0.1 (0.075±0.004)	3.5±0.1 (0.138±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
MCF0806 (0302)	0.4 (0.016)	0.75±0.05 (0.030±0.002)	0.95±0.05 (0.037±0.002)	2.0±0.05 (0.079±0.002)	0.55 (0.022)	0.3 (0.012)
MCF1210 (0504)	0.55(0.022)	1.15±0.05 (0.045±0.002)	1.40±0.05 (0.055±0.002)	4.0±0.1 (0.157±0.004)	0.65 (0.026)	0.3 (0.012)
MCF2010(0804)	0.45(0.018)	1.1±0.1 (0.043±0.004)	2.3±0.1 (0.091±0.004)	4.0±0.1 (0.157±0.004)	0.85 (0.033)	0.3 (0.012)
MCKK2012(0805)	1.0 (0.039)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.010)

Unit: mm(inch)

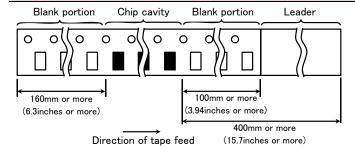
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Embossed Tape (4mm wide)

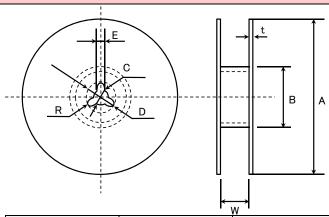


Туре	Thickness	Chip (cavity	Insertion Pitch	Tape Th	nickness
туре	mm(inch)	Α	В	F	K	Т
HKQ0402(01005)	0.2 (0.008)	0.23	0.43	1.0±0.02	0.5max.	0.25max.
					Unit	: mm

4LEADER AND BLANK PORTION



⑤Reel Size



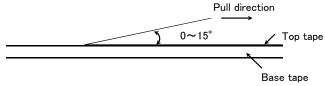
Α	В	С	D	E	R
ϕ 178 ± 2.0	ϕ 50 or more	ϕ 13.0 \pm 0.2	ϕ 21.0±0.8	2.0±0.5	1.0

	t	W
4mm width tape	1.5max.	5±1.0
8mm width tape	2.5max.	10±1.5

(Unit:mm)

$\ensuremath{\text{6}\text{Top}}$ tape strength

The top tape requires a peel-off force of $0.1 \sim 0.7 N$ in the direction of the arrow as illustrated below.



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Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

■RELIABILITY DATA

1. Operating Temper	rature Range		
	BK0402		
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		_55~+125°C
	BK1608		
	BK2125		
	ADDAY	BK2010	
	ARRAY	BK3216	
	BKP0402	•	
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		40 105%
	MCF 1210		-40~+85°C
	MCF 2010		
	CK1608		
0 15 11/1	CK2125		
Specified Value	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		40 105%
	CKP2520		-40~+85°C
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HKQ0402		
	HK0603		55~+125°C
	HK1005		
	HK1608		10 10590
	HK2125		-40~+85°C
	HKQ0603W/HK	Q0603C/HKQ0603S/	
	HKQ0603U/		-55~+125°C
	AQ105		
	MCFE1608		40 1 40 10 2 (2 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
	MCKK2012		-40~+125°C (Including self-generated heat)

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ure Range		
BK0402		
BK0603		
BK1005		
BKH0603		
BKH1005		-55~+125°C
BK1608		
BK2125		
ADDAV	BK2010	
ARRAT	BK3216	
BKP0402	•	
BKP0603		
BKP1005		-55~+85°C
BKP1608		
BKP2125		
MCF 0605		
MCF 0806		40 10500
MCF 1210		-40~+85°C
MCF 2010		
CK1608		
CK2125		
CKS2125		
CKP1608		
CKP2012		
CKP2016		40 10500
CKP2520		-40~+85°C
NM2012		
NM2520		
LK1005		
LK1608		
LK2125		
HKQ0402		
HK0603		55~+125°C
HK1005		
HK1608		40 L05 ⁰ 0
HK2125		-40~+85°C
HKQ0603W/H	KQ0603C/HKQ0603S/	
HKQ0603U/		-55~+125°C
AQ105		
MCFE1608		10 1000
MCKK2012		
	BK0402 BK0603 BK1005 BK1005 BK1005 BK1008 BK11005 BK1608 BK2125 ARRAY BKP0402 BKP0603 BKP1005 BKP1608 BKP125 MCF 0605 MCF 0806 MCF 1210 MCF 2010 CK1608 CK2125 CK2125 CK2125 CK2125 CK2125 CKP1608 CKP2012 CKP2016 CKP2012 CKP2016 CKP2012 HX0603 LK1005 LK1608 LK2125 HKQ0402 HK0603 HK1005 HK1608 HK1005 HK1608 HK2125 HKQ0603W/HHCQ0603W/HHCQ0603W/HCFE1608	BK0402 BK0603 BK1005 BK1005 BK1005 BK1608 BK11005 BK1608 BK2125 ARRAY BK3216 BK90603 BKP1005 BK91608 BKP2125 MCF 0605 MCF 0806 MCF 1210 MCF 2010 CK1608 CK2125 CKS2125 CKP2012 CKP2012 CKP2016 CKP2520 NM2012 NM2520 LK1005 LK1608 LK2125 HKQ0402 HK0603 HK1005 HK1608 LK2125 HKQ0402 HK0603 HK1005 HK1608 HK2125 HKQ0603W/HKQ0603C/HKQ0603S/ HKQ0603U/ AQ105 MCFE1608

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BK0402
BK0603
BK1005 BKH0603 BKH1005 BKH1005 BKH1005 BK1608 BK2125 BK2125 BK2010 BK200 BK90402 BK90603 BKP0603 BKP1005 BKP0603 BKP1005 BKP0603 BKP1005 BKP1005 BKP1005 BKP1608 BKP1005 BKP1608 BKP1005 BKP1608 BKP1005 BKP1608 BKP1095 BKP1608 BKP1095 BKP1
BKH0603
BKH1005 BK1608 BK2125 BK2125 BK2010 BK3216 BK216 BK9402 BKP0402 BKP0603 BKP1005 BKP1005 BKP1005 BKP1608 BKP125 BKP1608 BKP2125 BKP1608 BKP2125 BKP2
BK1608
BK2125 ARRAY BK2010 BK3216 100~200mA DC BKP0402 0.55~1.1A DC BKP0603 0.8~1.8A DC BKP1005 BKP1005 BKP1608 1.0~3.0A DC BKP2125 1.5~4.0A DC MCF 0605 MCF 0806 0.1~0.13A DC MCF 2010 MCF 2010 CK1608 CK2125 60~500mA DC CK52125 110~280mA DC CK52125 110~280mA DC CK52125 110~280mA DC CK52125
BK2010 100mA DC BK90402 0.55~1.1A DC BKP0603 0.8~1.8A DC BKP1005 0.8~2.4A DC BKP1608 1.0~3.0A DC BKP2125 1.5~4.0A DC MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 2010 0.1 ~0.15A DC CK12125 0.0~60mA DC CK2125 0.0~500mA DC CK2125 60~500mA DC CK2125 110~280mA DC
BK3216 100~200mA DC
BK3216 100~200mA DC
BKP0603
BKP1005 0.8~2.4A DC BKP1608 1.0~3.0A DC BKP2125 1.5~4.0A DC MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CK2125 60~500mA DC CKS125 110~280mA DC
BKP1608 1.0~3.0A DC BKP2125 1.5~4.0A DC MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CK2125 110~280mA DC
BKP2125 1.5~4.0A DC MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
MCF 0605 0.05A DC MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
MCF 0806 0.1~0.13A DC MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
MCF 1210 0.1~0.15A DC MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
MCF 2010 0.1A DC CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
CK1608 50~60mA DC CK2125 60~500mA DC CKS2125 110~280mA DC
CK2125 60~500mA DC CKS2125 110~280mA DC
CKS2125 110~280mA DC
CKS2125 110~280mA DC
Specified Value CKP1608 0.35~0.9A DC
CKP2012 0.7~1.7A DC
CKP2016 0.9∼1.6A DC
CKP2520 1.1∼1.8A DC
NM2012 1.0∼1.2A DC
NM2520 0.9∼1.2A DC
LK1005 20~25mA DC
LK1608 1 ~150mA DC
LK2125 5~300mA DC
HK0603 60~470mA DC
HK1005 110~300mA DC (-55~+125°C) 200~900mA DC (-55~+85°C)
HK1608 150~300mA DC
HK2125 300mA DC
HKQ0402 100~500mA DC
HKQ0603W 100~850mA DC
HKQ0603C 160~850mA DC
HKQ0603S 130~600mA DC
HKQ0603U 190~900mA DC
AQ105 280~710mA DC
MCFE1608
MCKK2012 Idc1 :2000mA DC, Idc2 :1400mA DC

Definition of rated current:

- ·In the CK, CKS and BK Series, the rated current is the value of current at which the temperature of the element is increased within 20°C.
- •In the BK Series P type, CK Series P type, NM Series, the rated current is the value of current at which the temperature of the element is increased within 40°C.
- •In the LK, HK, HKQ0603, and AQ Series, the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.
- •In the HKQ0402(~9N1), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.
- •In the HKQ0402(10N~), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 25°C.
- In the MC Series, Idc1 is the DC value at which the initial L value is decreased within 30% and Idc2 is the DC value at which the temperature of element is increased within 40°C by the application of DC bias. (at 20°C)

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4. Impedance				
	BK0402		$10\sim330\Omega \pm 5\Omega(10\Omega), \pm 25\%(Other)$	
	BK0603		10~1200Ω ±25%	
	BK1005		10~1800Ω ±25%	
	BKH0603		25~1500Ω ±25%	
	BKH1005		600~1800Ω ±25%	
	BK1608		22~2500Ω ±25%	
	BK2125		15~2500Ω ±25%	
	ARRAY BK2	010	5~1000Ω ±25%	
	BK3	216	60~1000Ω ±25%	
	BKP0402		$10\sim33\Omega \pm 5\Omega(10\Omega)$, $\pm25\%(Other)$	
	BKP0603		$10\sim120Ω \pm 5Ω(10Ω)$, $\pm25\%(Other)$	
	BKP1005		$10\sim330$ Ω ±5 Ω(EM100), ±25%(Other)	
	BKP1608		33~470Ω ±25%	
	BKP2125		33~330Ω ±25%	
	MCF 0605		$12 \sim 90 \Omega \pm 5 \Omega (12 \Omega)$, $\pm 20\% (35 \Omega)$, $\pm 25\% (Other)$	
	MCF 0806		$12 \sim 90 \Omega \pm 5 \Omega(12 \Omega)$, $\pm 20\%$ (Other)	
	MCF 1210		$40 \sim 90 \Omega \pm 20\% (2H900), \pm 25\% (Other)$	
	MCF 2010		90Ω ±25%	
	CK1608		-	
Specified Value	CK2125 CKS2125		-	
	CKP1608		-	
	CKP1008		-	
	CKP2012 CKP2016		-	
	CKP2520		-	
	NM2012		-	
	NM2520		-	
	LK1005		-	
	LK1608		-	
	LK2125		-	
	HKQ0402			
	HK0603			
	HK1005			
	HK1608			
	HK2125			
	HKQ0603W/HKQ0603C	/HKQ0603S/		
	HKQ0603U			
	AQ105			
	MCFE1608			
	MCKK2012			
	BK0402Series, BKP040			
	Measuring frequency	: 100±1MHz		
	Measuring equipment	: E4991A(or its eq		
	Measuring jig	: 16197A(or its eq	uivalent)	
	BK0603Series, BKP060			
	Measuring frequency	: 100±1MHz : 4291A(or its equi	inclose)	
	Measuring equipment Measuring jig	: 16193A(or its equi		
		5Series ,BKH1005Series	uivaiciit/	
Test Methods and	Measuring frequency	: 100±1MHz		
Remarks	Measuring equipment	: 4291A (or its equi	ivalent)	
riomanio	Measuring jig		uivalent), 16193A(or its equivalent)	
	BK1608 • 2125 Series, Bh			
	Measuring frequency	: 100±1MHz		
	Measuring equipment	: 4291A (or its equi	ivalent), 4195A(or its equivalent)	
	Measuring jig	: 16092A(or its eq	uivalent)or 16192A(or its equivalent)/HW	
	BK2010 • 3216 Series, M			
	Measuring frequency	: 100±1MHz		
	Measuring equipment		ivalent), 4195A(or its equivalent)	
	Measuring jig : 16192A(or its equi		uivalent)	

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5. Inductance	DIVO400		
	BK0402		
	BK0603		<u> </u>
	BK1005		<u> </u>
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY BK201)	
	BK321	3	_
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210]
	MCF 2010]
	CK1608		4.7~10.0 µH: ±20%
	CK2125		0.1~10.0 µH: ±20%
	CKS2125		1.0~10.0 µH: ±20%
	CKP1608		0.33~2.2 µH: ±20%
Specified Value	CKP2012		0.47~4.7 µH: ±20%
	CKP2016		0.47~4.7 µH: ±20%
	CKP2520		0.47~4.7 µH: ±20%
	NM2012		0.82~1.0 μH: ±20%
	NM2520		$1.0 \sim 2.2 \mu\text{H}$: $\pm 20\%$
	LK1005		0.12~2.2 µH: ±10 or 20%
	LK1608		0.047~33.0 μH: ±20% 0.10~12.0 μH: ±10%
	LK2125		0.047~33.0 µH: ±20% 0.10~12.0 µH: ±10%
	HK0603		1.0~6.2nH: ±0.3nH 6.8~100nH: ±5%
-	HK1005		1.0~6.2nH: ±0.3nH
	HK1608		1.0~5.6nH: ±0.3nH
	HK2125		1.5~5.6nH: ±0.3nH 6.8~470nH: ±5%
	HKQ0402		0.5~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~5.6nH: ±0.3nH or 3% or 5% 6.2~47nH: ±3 or 5%
			0.6~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~6.2nH: ±0.2 or 0.3nH or 3 or 5%
	HKQ0603W		6.8~27nH: ±3 or 5% 33~100nH: ±5%
	HKQ0603C		0.6~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~6.2nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%
	HKQ0603S		0.6~6.2nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%
	HKQ0603U		0.6~4.2nH: ±0.1 or 0.2 or 0.3nH 4.3~6.5nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%
	AQ105		1.0~6.2nH: ±0.3nH 6.8~15nH: ±5%
			0.24~1.0 µH: ±20%
	MCFE1608		1.0 μH: ±20%
-	MCKK2012	at a c	1.0 μπ. ±20%
	CK, LK, CKP, NM, MC S	:ries : 2~4MHz(CK1)	cuo)
	Measuring frequency Measuring frequency		
	Measuring frequency	: 2~25MHz(CK) : 2~10MHz(CK)	
	Measuring frequency	: 10~25MHz(Lk	
	Measuring frequency	: 1~50MHz(LK1	
	Measuring frequency	: 0.4~50MHz(LI	
	Measuring frequency		8 · CKP2012 · CKP2016 · CKP2520 · NM2012 · NM2520 · MCFE1608 · MCKK2012)
	Measuring equipment /jig		iB+16092A(or its equivalent) •4195A+41951+16092A(or its equivalent)
	Wodau ing equipment / Jig		2A(or its equivalent) •4291A+16193A(or its equivalent)/LK1005
			41A + 42842C + 42851 - 61100 (or its equivalent) / CKP1608 · CKP2012 · CKP2016 · CKP2520 · NM2012 ·
			E1608•MCKK2012
Test Methods and	Measuring current	:•1mA rms(0.04	
Remarks		•0.1mA rms(5.	
	HK、HKQ、AQ Series	• · · · · · · · · · · · · · · · · · · ·	
	Measuring frequency	· 100MHz (HK06)	03•HK1005•AQ105)
	Measuring frequency	: 50/100MHz(H	
	Measuring frequency		1603C·HKQ0603S·HKQ0603U)
	Measuring frequency	: 300/500MHz(H	
	Measuring frequency	: 100/500MHz(H	
	Measuring equipment /jig		A(or its equivalent)/HK0603•AQ105
	3 ,		3A(or its equivalent)/HK1005
			97A(or its equivalent)/HKQ0603S+HKQ0603U+HKQ0603W+HKQ0603C
			2A + in-house made jig(or its equivalent)/HK1608•HK2125
			96D (or its equivalent) /HKQ0402

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6. Q			
	BK0402		
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY BK2010		
	BK3216		_
	BKP0402		-
	BKP0603		-
	BKP1005		-
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		-
	MCF 2010		
	CK1608 CK2125		1
	CKS2125		-
Specified Value	CK92123 CKP1608		1
	CKP2012		_
	CKP2016		1
	CKP2520		1
	NM2012		
	NM2520		
	LK1005		10~20 min.
	LK1608		10~35 min.
	LK2125		15∼50 min.
	HK0603		4~5 min.
	HK1005		8 min.
	HK1608		8~12 min.
	HK2125		10~18 min.
	HKQ0402		3∼8 min.
	HKQ0603W		6~15 min.
	HKQ0603C		14∼15 min.
	HKQ0603S		10~13 min.
	HKQ0603U		14 min.
	AQ105		8 min.
	MCFE1608		_
	MCKK2012 LK Series		
	Measuring frequency	: 10~25MHz(LK10	105)
	Measuring frequency	: 1~50MHz(LK160	
	Measuring frequency	: 0.4~50MHz(LK21	
	Measuring equipment /jig		+16092A(or its equivalent)
			-16092A(or its equivalent)
			(or its equivalent)
			(or its equivalent)/LK1005
	Measuring current	1mA rms(0.047	
Test Methods and		•0.1mA rms(5.6~	γ33 μH)
Remarks	HK, HKQ, AQ Series	1001111 /11/0000	LIKTORE ACTOR)
	Measuring frequency	: 100MHz(HK0603• : 50/100MHz(HK16	
	Measuring frequency Measuring frequency		30°HKQ0603S•HKQ0603U)
	Measuring frequency	: 300/500MHz(HKC	
	Measuring frequency	: 100/500MHz(HKC	
	Measuring equipment /jig		or its equivalent)/HK0603·AQ105
			(or its equivalent)/HK1005
		•E4991A+16197A	A(or its equivalent)/HKQ0603S+HKQ0603U+HKQ0603W+HKQ0603C
			+ in-house made jig(or its equivalent)/HK1608, HK2125
		•E4991A+16196	D(or its equivalent)HKQ0402
	·	·	

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	BK0402		0.07∼1.2Ωmax.
	BK0603		0.065~1.50 Ω max.
	BK1005		0.03~0.90Ω max.
	BKH0603		0.26~3.20 Ω max.
	BKH1005		0.85~2.00 Ω max.
	BK1608		0.05~1.10 Ω max.
	BK2125		0.05~0.75Ω max.
	ARRAY	BK2010	0.10~0.90 Ω max.
	ARRAT	BK3216	0.15~0.80 Ω max.
	BKP0402		0.05~0.15 Ω max.
	BKP0603		0.030~0.180Ω max.
	BKP1005		0.0273~0.220 Ω max.
	BKP1608		0.025~0.18 Ω max.
	BKP2125		0.020~0.075Ω max.
	MCF 0605		2.5~6.5 Ω max
	MCF 0806		2.5∼5.0 Ω max.
	MCF 1210		2.5~4.5 Ω max.
	MCF 2010		4.5Ω max.
	CK1608		$0.45 \sim 0.85 \Omega(\pm 30\%)$
	CK2125		0.16∼0.65 Ω max.
pecified Value	CKS2125		0.12∼0.52 Ω max.
Deciried Value	CKP1608		0.15~0.35 Ω max.
	CKP2012		0.08∼0.28 Ω max.
	CKP2016		0.075∼0.20 Ω max
	CKP2520		0.05∼0.16Ω max.
	NM2012		0.10~0.15Ω max.
	NM2520		0.11∼0.22 Ω max.
	LK1005		0.41∼1.16Ω max.
	LK1608		0.2~2.2Ω max.
	LK2125		0.1~1.1Ω max.
	HK0603		0.11~3.74Ω max.
	HK1005		0.08~4.8 Ω max.
	HK1608		0.05~2.6 Ω max.
	HK2125		0.10∼1.5Ω max.
	HKQ0402		0.08~5.0Ω max.
	HKQ0603W		0.07~4.1 Ω max.
	HKQ0603C		0.07~1.6Ω max.
	HKQ0603S		0.06~1.29 Ω max.
	HKQ0603U		0.06~1.29 Ω max.
	AQ105		0.07~0.45 Ω max.
	MCFE1608		0.100~0.340 Ω max.
ļ	MCKK2012		0.123 Ω max.

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8. Self Resonance Fre			
	BK0402		
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		17∼25MHz min.
	CK2125		24~235MHz min.
Specified Value	CKS2125		24~75MHz min.
Specified value	CKP1608		
	CKP2012		
	CKP2016		_
	CKP2520		
	NM2012		
	NM2520		
	LK1005		40~180MHz min.
	LK1608		9~260MHz min.
	LK2125		13∼320MHz min.
	HK0603		900∼10000MHz min.
	HK1005		400∼10000MHz min.
	HK1608		300∼10000MHz min.
	HK2125		200∼4000MHz min.
	HKQ0402		1200~10000MHz min.
	HKQ0603W		800∼10000MHz min.
	HKQ0603C		2500~10000MHz min.
	HKQ0603S		1900~10000MHz min.
	HKQ0603U		1900~10000MHz min.
	AQ105		2300~10000MHz min.
	MCFE1608		
	MCKK2012		_
	LK, CK Series :		
T . M	Measuring equip	oment : 4195A (or its equi	valent)
Test Methods and	Measuring jig	: 41951+16092A (or its equivalent)
Remarks	HK, HKQ, AQ Se	eries :	
	Measuring equip	oment : 8719C(or its equi	ivalent) •8753D (or its equivalent) /HK2125

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9. Temperature Chara					
	BK0402				
	BK0603				
	BK1005				
	BKH0603				
	BKH1005				
	BK1608				
	BK2125				
		BK2010			
		BK3216			
	BKP0402				
	BKP0603				
	BKP1005				
	BKP1608				
	BKP2125				
	MCF 0605			7	
	MCF 0806				_
	MCF 1210				
	MCF 2010				
	CK1608			7	
	CK2125			1	
	CKS2125			1	
Specified Value	CKP1608			7	
	CKP2012			7	
	CKP2016			7	
	CKP2520			1	
	NM2012			7	
	NM2520				
	LK1005			7	
	LK1608			٦	
	LK2125			٦	
	HK0603			†	
	HK1005			1	
	HK1608			┪	
	HK2125			┪	
	HKQ0402			┪	
	HKQ0402 HKQ0603W			┪	
	HKQ0603V			┥	Inductance change: Within ±10%
				┪	
	HKQ0603S			\dashv	
	HKQ0603U			4	
	AQ105			4	
	MCFE1608			4	
	MCKK2012				
	HK、HKQ、AQ Seri				
	Temperature rang		: −30~+85°C		
Test Methods and	Reference temper	ature	: +20°C		
Remarks	MC Series:		40 1.0=05		
	Temperature rang		: −40~+85°C		
	Reference temper	ature	: +20°C		

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10. Resistance to Flex	ure of Substrate		
	BK0402		
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
		BK2010	
	ARRAY	BK3216	
	BKP0402	BROZIO	
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608 CK2125		
Specified Value	CKS2125		No mechanical damage.
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		
	Warp		ize, BKP, BKH1005, CK, CKS, CKP, NM, LK, HK, HKQ0603S, HKQ0603U,
		AQ Series, MCF1210, MC Ser	
	To add to a 1		0603、HKQ0402、HKQ0603W、HKQ0603C Series、MCF Series without 1210 size,)
	Testing board	: glass epoxy-resin substrate	
	Thickness	: 0.8mm	
		<u>20</u>	
Test Methods and		[D 220]	
Remarks		Board R-230	w
		Board	Warp
			\
			14
		45 45	
		← → ←	→
		1 1	(Unit:mm)
	Ī		

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11 0-14							
11. Solderability	BK0402						
	BK0603						
	BK1005						
	BKH0603						
	BKH1005						
	BK1608						
	BK2125						
		BK2010					
	ARRAY	BK3216			<u></u>		
	BKP0402				At least 75% of terminal electrode is covered by new solder.		
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605						
	MCF 0806						
	MCF 1210						
	MCF 2010						
	CK1608						
Specified Value	CK2125						
	CKS2125						
	CKP1608						
	CKP2012						
	CKP2016						
	CKP2520						
	NM2012						
	NM2520 LK1005						
	LK1608						
	LK2125 HK0603				At least 75% of terminal electrode is covered by new solder.		
	HK1005						
	HK1608						
	HK2125						
	HKQ0402						
	HKQ0603W						
	HKQ0603C						
	HKQ0603S						
	HKQ0603U						
	AQ105						
	MCFE1608						
	MCKK2012						
Test Methods and	Solder temperati	ure	:230±5°	C (JIS Z 32	32 H60A or H63A)		
Remarks	Solder temperatu	ure	:245±3°	C (Sn/3.0Ag	s/0.5Cu)		
I Ciliai NS	Duration :4±1 sec.			э.			

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10 D 11 1 2 11						
12. Resistance to Sold						
1	BK0402			-		
ĺ	BK0603					
1	BK1005			-		
Í	BKH0603			-		
	BKH1005			1		
	BK1608			1		
!	BK2125	Τ		Appearance: No significant abnormality		
1	ARRAY BK2010			Impedance change: Within ±30%		
!		BK3216		1		
!	BKP0402			-		
!	BKP0603			1		
!	BKP1005			1		
	BKP1608			1		
!	BKP2125					
	MCF 0605			1		
	MCF 0806			Appearance: No significant abnormality		
!	MCF 1210			Impedance change: Within ±20%		
	MCF 2010					
!	CK1608			No mechanical damage.		
	CK2125			No mechanical damage. Remaining terminal electrode: 70% min		
!	CKS2125			Transming communications and a second section of the section of the second section of the sect		
!	CKP1608			Inductance change		
	CKP2012			R10~4R7: Within ±10%		
Specified Value	CKP2016			6R8~100: Within ±15%		
!	CKP2520			CKS2125 : Within ±20%		
!	NM2012			CKP1608, CKP2012, CKP2016, CKP2520, NM2012, NM2520: Within ±30%		
	NM2520					
1	l	_		No mechanical damage.		
	LK1005			Remaining terminal electrode: 70% min.		
!	11/4000			Inductance change: Within ±15%		
!	LK1608		-	No mechanical damage.		
!				Remaining terminal electrode: 70% min.		
!	LK2125			Inductance change		
!				47N~4R7: Within ±10% 5R6~330: Within ±15%		
	HK0603		_	5R6~330: Within ±15%		
!	HK0603 HK1005		_			
!			_			
1	HK1608 HK2125			No mechanical damage.		
!			_			
!	HKQ0402 HKQ0603W		_	Remaining terminal electrode: 70% min.		
1	HKQ0603W HKQ0603C		_	Inductance change: Within ±5%		
!	HKQ0603C HKQ0603S			1		
!	HKQ0603S HKQ0603U			1		
!				1		
1	AQ105			No machanical damage		
!	MCFE1608			No mechanical damage. Remaining terminal electrode: 70% min.		
1	MCKK2012	MCKK2012		Remaining terminal electrode: /0% min. Inductance change: Within ±10%		
	Solder temperatu	_		1 10/0		
!	Duration	. 5	:10±0.5 sec.			
Test Methods and	Preheating tempe	rature	:150 to 180°C			
Remarks	Preheating time		: 3 min.			
	_			methanol solution with colophony for 3 to 5 sec.		
1				covery under the standard condition after the test. (See Note 1)		
(Note 1) When there as		rning measureme		ement shall be made after 48±2 hrs of recovery under the standard condition.		
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13. Thermal Shock						
	BK0402					
	BK0603					
	BK1005					
	BKH0603					
	BKH1005		1			
	BK1608					
	BK2125		Appearance: No sig	gnificant abnormality		
		BK2010	Impedance change			
	ARRAY	BK3216	1			
	BKP0402		1			
	BKP0603		1			
	BKP1005					
	BKP1608		1			
	BKP2125					
	MCF 0605					
	MCF 0806		Appearance: No sig	gnificant abnormality		
	MCF 1210		Impedance change	: Within ±20%		
	MCF 2010					
	CK1608		No mechanical dam	nage.		
	CK2125		Inductance change:Within ±20% Q change:Within ±30%			
	CKS2125		Inductance change: Within ±20% (CKS2125)			
Specified Value	CKP1608	CKP1608				
	CKP2012		1			
	CKP2016		No mechanical dam	nage.		
	CKP2520		Inductance change: Within ±30%			
	NM2012					
	NM2520					
	LK1005					
	LK1608			No mechanical damage.		
	LK2125		Inductance change: Within ±10% Q change: Within ±30%			
	HK0603					
	HK1005					
	HK1608					
	HK2125		No mechanical damage. Inductance change: Within ±10% Q change: Within ±20%			
	HKQ0402					
	HKQ0603W					
	HKQ0603C					
	HKQ0603S					
	HKQ0603U					
	AQ105		†			
	MCFE1608		Appearance: No significant abnormality			
	MCKK2012		Inductance change: Within ±10%			
	Conditions for 1	cycle	•			
	Step	temperature(°C)		time (min.)		
	1	Minimum operating temperatur	re +0/-3	30±3		
Test Methods and	2	Room temperature		2~3		
Remarks	3	Maximum operating temperatur	re +3/-0	30±3		
	4	Room temperature		2~3		
	Number of cycle	s:5				
	Recovery: 2 to 3	hrs of recovery under the standar	d condition after the	test.(See Note 1)		

(Note 1) When there are questions concerning measurement result; measurement shall be made after 48±2 hrs of recovery under the standard condition.

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14. Damp Heat (Stea	dy state)					
	BK0402					
	BK0603					
	BK1005					
	BKH0603					
	BKH1005					
	BK1608					
	BK2125		Appearance: No significant abnormality			
	BK2010		Impedance change: Within ±30%			
	ARRAY	BK3216				
	BKP0402	5.02.0				
	BKP0603					
	BKP1005					
	BKP1608					
	BKP2125					
	MCF 0605					
	MCF 0806		Appearance: No significant abnormality			
	MCF 1210		Impedance change: Within ±20%			
	MCF 1210		ampounted straings. Highlin ±2070			
			No mark of desired desired			
	CK1608		No mechanical damage.			
	CK2125		Inductance change: Within ±20% Q change: Within ±30% Inductance change: Within ±20%			
C: G! \/-!	CKS2125		Inductance change: Within ±20%			
Specified Value	CKP1608					
	CKP2012					
	CKP2016		No mechanical damage.			
	CKP2520		Inductance change: Within ±30%			
	NM2012					
	NM2520					
	LK1005		No mechanical damage.			
	LK1608		Inductance change: Within ±10% Q change: Within ±30%			
	LK2125		No mechanical damage.			
			Inductance change: Within ±20% Q change: Within ±30%			
	HK0603					
	HK1005					
	HK1608					
	HK2125		No mechanical damage.			
	HKQ0402					
	HKQ0603W		Inductance change: Within ±10% Q change: Within ±20%			
	HKQ0603C					
	HKQ0603S					
	HKQ0603U					
	AQ105					
	MC1608		Appearance: No significant abnormality			
	MC2012		Inductance change: Within ±10%			
<u> </u>	BK, BKP, BKH	Series, MCF Series:				
	Temperature	:40±2°C				
	Humidity	:90 to 95%RH				
	Duration	:500+24/-0 hrs				
	Recovery	:2 to 3 hrs of recovery under the	ne standard condition after the removal from test chamber.(See Note 1)			
Test Methods and						
Remarks		KP, NM, HK, HKQ, AQ, MC Series				
	Temperature	:40±2°C(LK, CK, CKS, CKP				
		:60±2°C(HK, HKQ, AQ, MC	Series)			
	Humidity	:90 to 95%RH				
	Duration	:500±12 hrs				
41	Recovery		ne standard condition after the removal from test chamber. (See Note 1)			
(Note 1) When there a	are questions conce	erning measurement result; measure	ement shall be made after 48±2 hrs of recovery under the standard condition.			

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45 1 2 1 5					
15. Loading under Dar					
	BK0402				
	BK0603		4		
	BK1005		-		
	BKH0603		-		
	BKH1005		4		
	BK1608				
	BK2125		Appearance: No significant abnormality		
	ARRAY	K2010	Impedance change: Within ±30%		
		K3216	4		
	BKP0402		4		
	BKP0603		4		
	BKP1005		4		
	BKP1608				
	BKP2125				
	CK1608		No mechanical damage.		
	CK2125		Inductance change: Within ±20% Q change: Within ±30%		
	CKS2125		No mechanical damage. Inductance change: Within ±20%		
	CKP1608				
	CKP2012				
	CKP2016		No mechanical damage.		
Specified Value	CKP2520		Inductance change: Within ±30%		
	NM2012				
	NM2520				
	LK1005		No mechanical damage. Inductance change: Within ±10% Q change: Within ±30%		
	LK1608		No mechanical damage. Inductance change: 0.047~12.0 H: Within ±10% 15.0~33.0 H: Within ±15% Q change: Within ±30%		
	LK2125		No mechanical damage. Inductance change: Within ±20% Q change: Within ±30%		
	HK0603				
	HK1005		1		
	HK1608				
	HK2125		1		
	HKQ0402		No mechanical damage.		
	HKQ0603W		Inductance change: Within ±10% Q change: Within ±20%		
	HKQ0603C				
	HKQ0603S		1		
	HKQ0603U		1		
	AQ105		1		
	MCFE1608		Appearance: No significant abnormality		
	MCKK2012		Inductance change: Within ±10%		
	BK、BKP、BKH Serie	s:			
	Temperature	:40±2°C			
	Humidity	:90 to 95%RH			
	Applied current	: Rated current			
	Duration	:500+24/-0 hrs			
Test Methods and	Recovery		der the standard condition after the removal from test chamber. (See Note 1)		
Remarks		NK, HK, HKQ, AQ, MC Serie			
	Temperature	:40±2°C(LK, CK, CKS,			
	Humidity	:60±2°C(HK, HKQ, AQ.	, INC Series)		
	Humidity	:90 to 95%RH			
	Applied current Duration	:Rated current :500±12 hrs			
	Recovery		der the standard condition after the removal from test chamber (See Note 1)		
Note on standard con	Recovery :2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1)				

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to $35^{\circ}\!C\,$ of temperature, 45 to 85% relative humidity, and 86 to 106 kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of 20 ± 2°C of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure.

Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

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16. Loading at High To	emperature					
	BK0402					
	BK0603		-			
	BK1005					
	BKH0603					
	BKH1005					
	BK1608		1			
	BK2125		Appearance: No significant abnormality			
	ARRAY	BK2010	Impedance change: Within ±30%			
	70000	BK3216				
	BKP0402					
	BKP0603					
	BKP1005					
	BKP1608					
	BKP2125					
	MCF 0605					
			Annual National Control of the Contr			
	MCF 0806		Appearance: No significant abnormality			
	MCF 1210		Impedance change: Within ±20%			
	MCF 2010					
	CK1608		No mechanical damage.			
	CK2125		Inductance change: Within ±20% Q change: Within ±30%			
	CK53135		No mechanical damage.			
	CKS2125		Inductance change: Within ±20%			
	CKP1608					
Specified Value	CKP2012					
opcomed value	CKP2016		No mechanical damage.			
	CKP2520		Inductance change: Within ±30%			
			Inductance change. Within ±3070			
	NM2012					
	NM2520					
	LK1005		No mechanical damage.			
			Inductance change: Within ±10% Q change: Within ±30%			
			No mechanical damage.			
	LK1608		Inductance change: $0.047 \sim 12.0 \mu\text{H}$: Within $\pm 10\%$ $15.0 \sim 33.0 \mu\text{H}$: Within $\pm 15\%$			
			Q change: Within ±30%			
	LK2125		No mechanical damage.			
	LINZTZS		Inductance change: Within ±20% Q change: Within ±30%			
	HK0603					
	HK1005		No mechanical damage.			
	HK1608					
	HK2125					
	HKQ0402					
	HKQ0603W		Inductance change: Within ±10% Q change: Within ±20%			
	HKQ0603C		Inductance change. Within ±1070 & change. Within ±2070			
	HKQ0603S					
	HKQ0603U					
	AQ105					
	MCFE1608		Appearance: No significant abnormality			
	MCKK2012		Inductance change: Within ±10%			
	MCKK2012	eries、MCF Series:				
	MCKK2012	eries、MCF Series: :125±3°C(BK、BKH Series)				
	MCKK2012 BK, BKH, BKP Se					
	MCKK2012 BK、BKH、BKP So Temperature	: 125±3°C(BK, BKH Series)				
	MCKK2012 BK、BKH、BKP So Temperature	: 125±3°C(BK, BKH Series) : 85±3°C(BKP, MCF Series)				
	MCKK2012 BK, BKH, BKP Son Temperature Applied current	: 125±3°C(BK, BKH Series) : 85±3°C(BKP, MCF Series) : Rated current :500+24/-0 hrs				
Total Matheda and	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration	: 125±3°C(BK, BKH Series) : 85±3°C(BKP, MCF Series) : Rated current :500+24/-0 hrs	Inductance change: Within ±10%			
Test Methods and	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery	: 125±3°C(BK, BKH Series) : 85±3°C(BKP, MCF Series) :Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under the	Inductance change: Within ±10% ne standard condition after the removal from test chamber.			
Test Methods and Remarks	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) :Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under the (See Note 1)	Inductance change: Within ±10% ne standard condition after the removal from test chamber. s:			
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) :Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under the (See Note 1) (P, NM, HK, HKQ, AQ, MC Serie	Inductance change: Within ±10% ne standard condition after the removal from test chamber. s:			
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) :Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under th (See Note 1) (P, NM, HK, HKQ, AQ, MC Serie : 85±2°C (LK, CK, CKS, CKP, : 85±2°C (HK1608, 2125)	Inductance change: Within ±10% ne standard condition after the removal from test chamber. s:			
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) : Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under th (See Note 1) (P, NM, HK, HKQ, AQ, MC Serie : 85±2°C (LK, CK, CKS, CKP, : 85±2°C (HK1608, 2125) : 85±2°C (HK1005, AQ105 oper	Inductance change: Within ±10% the standard condition after the removal from test chamber. S: NM, MC Series)			
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) : Rated current : 500+24/-0 hrs : 2 to 3 hrs of recovery under the series of the series	Inductance change: Within ±10% The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber.			
	MCKK2012 BK, BKH, BKP Soft Temperature Applied current Duration Recovery LK, CK, CKS, CK	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) : Rated current : 500+24/-0 hrs : 2 to 3 hrs of recovery under the (See Note 1) (P, NM, HK, HKQ, AQ, MC Series) : 85±2°C (LK, CK, CKS, CKP, 185±2°C (HK1608, 2125) : 85±2°C (HK1005, AQ105 oper 125±2°C (HKQ0402, HK0603, operating temperature	Inductance change: Within ±10% the standard condition after the removal from test chamber. s: NM、MC Series) ating temperature range—55~+85°C)			
	MCKK2012 BK, BKH, BKP So Temperature Applied current Duration Recovery LK, CK, CKS, CK Temperature Applied current	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) :Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under the (See Note 1) (P, NM, HK, HKQ, AQ, MC Serie) : 85±2°C (LK, CK, CKS, CKP, CKP, CKP, CKP, CKP, CKP, CKP, CKP	Inductance change: Within ±10% The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber.			
	MCKK2012 BK, BKH, BKP So Temperature Applied current Duration Recovery LK, CK, CKS, CK Temperature	: 125±3°C (BK, BKH Series) : 85±3°C (BKP, MCF Series) :Rated current :500+24/-0 hrs :2 to 3 hrs of recovery under the series of	Inductance change: Within ±10% The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber. The standard condition after the removal from test chamber.			

5 to $35^{\circ}\!C$ of temperature, 45 to 85% relative humidity, and 86 to 106 kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of 20±2°C of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

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Precautions on the use of Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOILTM MC series)

PRECAUTIONS

1. Circuit Design

- ◆ Verification of operating environment, electrical rating and performance
 - 1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications

Precautions

As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.

- ◆Operating Current(Verification of Rated current)
 - 1. The operating current for inductors must always be lower than their rated values.
 - 2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.

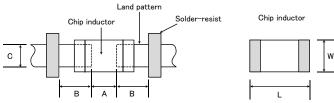
2. PCB Design

Precautions

- ◆Pattern configurations (Design of Land-patterns)
- 1. When inductors are mounted on a PCB, the size of land patterns and the amount of solder used (size of fillet) can directly affect inductor performance.

Therefore, the following items must be carefully considered in the design of solder land patterns:

- (1) The amount of solder applied can affect the ability of chips to withstand mechanical stresses which may lead to breaking or cracking. Therefore, when designing land-patterns it is necessary to consider the appropriate size and configuration of the solder pads which in turn determines the amount of solder necessary to form the fillets.
- (2) When more than one part is jointly soldered onto the same land or pad, the pad must be designed so that each component's soldering point is separated by solder-resist.
- (3) The larger size of land patterns and amount of solder, the smaller Q value after mounting on PCB. It makes higher the Q value to design land patterns smaller than terminal electrode of chips.
- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1. After inductors have been mounted on the boards, chips can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering the reflow soldered boards etc.) For this reason, planning pattern configurations and the position of SMD inductors should be carefully performed to minimize stress.
- ◆Pattern configurations(Design of Land-patterns)
 - The following diagrams and tables show some examples of recommended patterns to prevent excessive solder amounts (larger fillets which extend above the component end terminations). Examples of improper pattern designs are also shown.
 - (1) Recommended land dimensions for a typical chip inductor land patterns for PCBs



Recommended land dimensions for wave-soldering (Unit:mm)

Ту	ре	1608	2012	2125	2016	2520	3216
Size	┙	1.6	2.0	2.0	2.0	2.5	3.2
Size	W	0.8	1.25	1.25	1.6	2.0	1.6
A	١	0.8~1.0	1.0~1.4	1.0~1.4	1.0~1.4	1.0~1.4	1.8~2.5
В		0.5~0.8	0.8~1.5	0.8~1.5	0.8~1.5	0.6~1.0	0.8~1.7
С		0.6~0.8	0.9~1.2	0.9~1.2	1.3~1.6	1.6~2.0	1.2~1.6

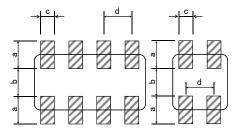
Technical considerations

Recommended land dimensions for reflow-soldering (Unit:mm)

T	уре	0402	0603	1005	105	1608	2012	2125	2016	2520	3216
Size	L	0.4	0.6	1.0	1.0	1.6	2.0	2.0	2.0	2.5	3.2
Size	W	0.2	0.3	0.5	0.6	0.8	1.25	1.25	1.6	2.0	1.6
	A	0.15~0.25	0.20~0.30	0.45~0.55	0.50~0.55	0.8~1.0	0.8~1.2	0.8~1.2	0.8~1.2	1.0~1.4	1.8~2.5
	В	0.10~0.20	0.20~0.30	0.40~0.50	0.30~0.40	0.6~0.8	0.8~1.2	0.8~1.2	0.8~1.2	0.6~1.0	0.6~1.5
	С	0.15~0.30	0.25~0.40	0.45~0.55	0.60~0.70	0.6~0.8	0.9~1.6	0.9~1.6	1.2~2.0	1.8~2.2	1.2~2.0

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Excess solder can affect the ability of chips to withstand mechanical stresses. Therefore, please take proper precautions when designing land-patterns.



Type		3216	2010	1210	0806	0605
C:	L	3.2	2.0	1.25	0.85	0.65
Size	W	1.6	1.0	1.0	0.65	0.50
а		0.7~0.9	0.5~0.6	0.45~0.55	0.25~0.35	0.27~0.33
b		0.8~1.0	0.5~0.6	0.7~0.8	0.25~0.35	0.17~0.23
С		0.4~0.5	0.2~0.3	0.25~0.35	0.25~0.35	0.20~0.26
d		8.0	0.5	0.55	0.5	0.4

(Unit:mm)

((2) Examples of good and bad solder application

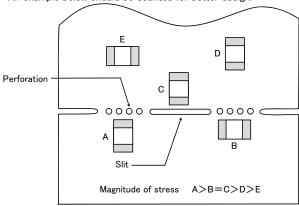
É	Examples of good and bad solde		
L	Item	Not recommended	Recommended
	Mixed mounting of SMD and leaded components	Lead wire of component	Solder-resist
	Component placement close to the chassis	Chassis Solder (for grounding) Electrode pattern	Solder-resist
	Hand-soldering of leaded components near mounted components	Lead wire of component Soldering iron	Solder-resist
	Horizontal component placement		Solder-resist

- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1-1. The following are examples of good and bad inductor layout; SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection.

Item	Not recommended	Recommended
Deflection of the board		Position the component at a right angle to the direction of the mechanical stresses that are anticipated.

1-2. To layout the inductors for the breakaway PC board, it should be noted that the amount of mechanical stresses given will vary depending on inductor layout.

An example below should be counted for better design.



1-3. When breaking PC boards along their perforations, the amount of mechanical stress on the inductors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, any ideal SMD inductor layout must also consider the PCB splitting procedure.

3. Considerations for automatic placement

- ◆Adjustment of mounting machine
 - 1. Excessive impact load should not be imposed on the inductors when mounting onto the PC boards.
 - 2. The maintenance and inspection of the mounter should be conducted periodically.

Precautions

◆ Selection of Adhesives

- 1. Mounting inductors with adhesives in preliminary assembly, before the soldering stage, may lead to degraded inductor characteristics unless the following factors are appropriately checked; the size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, it is imperative to consult the manufacturer of the adhesives on proper usage and amounts of adhesive to use.
- ◆Adjustment of mounting machine
 - 1. If the lower limit of the pick-up nozzle is low, too much force may be imposed on the inductors, causing damage. To avoid this, the following points should be considered before lowering the pick-up nozzle:
 - The lower limit of the pick-up nozzle should be adjusted to the surface level of the PC board after correcting for deflection of the board.
 - (2) The pick-up pressure should be adjusted between 1 and 3N static loads.
 - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins should be used under the PC board. The following diagrams show some typical examples of good pick-up nozzle placement:

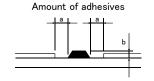
Item	Improper method	Proper method
Single-sided mounting	chipping or cracking	supporting pins — or back-up pins
Double-sided mounting	chipping or cracking	supporting pins or back-up pins

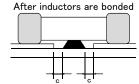
Technical considerations

- 2. As the alignment pin wears out, adjustment of the nozzle height can cause chipping or cracking of the inductors because of mechanical impact on the inductors. To avoid this, the monitoring of the width between the alignment pin in the stopped position, and maintenance, inspection and replacement of the pin should be conducted periodically.
- ◆Selection of Adhesives
 - 1. Some adhesives may cause reduced insulation resistance. The difference between the shrinkage percentage of the adhesive and that of the inductors may result in stresses on the inductors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect component placement, so the following precautions should be noted in the application of adhesives.
 - (1) Required adhesive characteristics
 - a. The adhesive should be strong enough to hold parts on the board during the mounting & solder process.
 - b. The adhesive should have sufficient strength at high temperatures.
 - c. The adhesive should have good coating and thickness consistency.
 - d. The adhesive should be used during its prescribed shelf life.
 - e. The adhesive should harden rapidly.
 - f. The adhesive must not be contaminated.
 - g. The adhesive should have excellent insulation characteristics.
 - h. The adhesive should not be toxic and have no emission of toxic gasses.
 - (2) When using adhesives to mount inductors on a PCB, inappropriate amounts of adhesive on the board may adversely affect component placement. Too little adhesive may cause the inductors to fall off the board during the solder process. Too much adhesive may cause defective soldering due excessive flow of adhesive on to the land or solder pad.

[Recommended conditions]

Figure	0805 case sizes as examples	
а	0.3mm min	
b	100∼120 μm	
С	Area with no adhesive	





4. Soldering

Precautions

◆Selection of Flux

- 1. Since flux may have a significant effect on the performance of inductors, it is necessary to verify the following conditions prior to use;
 - (1) Flux used should be with less than or equal to 0.1 wt% (Chlorine conversion method) of halogenated content. Flux having a strong acidity content should not be applied.
 - (2) When soldering inductors on the board, the amount of flux applied should be controlled at the optimum level.
 - (3) When using water-soluble flux, special care should be taken to properly clean the boards.

◆Soldering

1. Temperature, time, amount of solder, etc. are specified in accordance with the following recommended conditions, and please contact us about peak temperature when you use lead-free paste.

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◆Selection of Flux

- 1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate the flux, or highly acidic flux is used, an excessive amount of residue after soldering may lead to corrosion of the terminal electrodes or degradation of insulation resistance on the surface of the Inductor.
- 1-2. Flux is used to increase solderability in flow soldering, but if too much is applied, a large amount of flux gas may be emitted and may detrimentally affect solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved by water content in the air, the residue on the surface of Inductor in high humidity conditions may cause a degradation of insulation resistance and therefore affect the reliability of the components. The cleaning methods and the capability of the machines used should also be considered carefully when selecting water-soluble flux.

◆Soldering

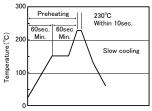
1-1. Preheating when soldering

Heating: Chip inductor components should be preheated to within $100 \text{ to } 130^{\circ}\text{C}$ of the soldering. Cooling: The temperature difference between the components and cleaning process should not be greater than 100°C .

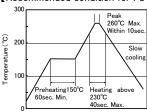
Chip inductors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling. Therefore, the soldering process must be conducted with a great care so as to prevent malfunction of the components due to excessive thermal shock.

[Reflow soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]



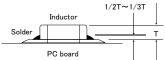
%Ceramic chip components should be preheated to within 100 to 130°C of the soldering.

*Assured to be reflow soldering for 2 times.

Caution

Technical considerations

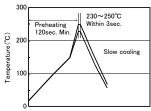
1. The ideal condition is to have solder mass(fillet) controlled to 1/2 to 1/3 of the thickness of the inductor, as shown below:



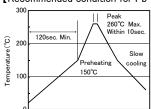
2. Because excessive dwell times can detrimentally affect solderability, soldering duration should be kept as close to recommended times as possible.

[Wave soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]



 $\rm \& Ceramic$ chip components should be preheated to within 100 to 130 $\rm ^{\circ}C$ of the soldering.

Assured to be wave soldering for 1 time.

Except for reflow soldering type.

Assured to be wave soldering type.

Assured to be wave soldering type.

Assured to be wave soldering for 1 time.

Assured to be wave soldering type.

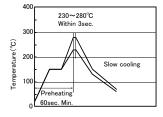
Assured to be wave s

Caution

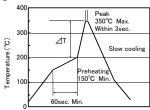
- 1. Make sure the inductors are preheated sufficiently.
- 2. The temperature difference between the inductor and melted solder should not be greater than 100 to 130° C.
- 3. Cooling after soldering should be as gradual as possible.
- 4. Wave soldering must not be applied to the inductors designated as for reflow soldering only.

[Hand soldering]

[Recommended conditions for eutectic soldering



[Recommended condition for Pb-free soldering]



(**※**⊿T≦190°C(3216Type max), ⊿T≦130°C(3225 Type min)

%It is recommended to use 20W soldering iron and the tip is 1 ϕ or less.

*The soldering iron should not directly touch the components.

XAssured to be soldering iron for 1 time

Note: The above profiles are the maximum allowable soldering condition, therefore these profiles are not always recommended.

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Caution 1. Use a 20W soldering iron with a maximum tip diameter of 1.0 mm. 2. The soldering iron should not directly touch the inductor.

5. Cleaning

Precautions

considerations

♦Cleaning conditions

- 1. When cleaning the PC board after the Inductors are all mounted, select the appropriate cleaning solution according to the type of flux used and purpose of the cleaning (e.g. to remove soldering flux or other materials from the production process.)
- 2. Cleaning conditions should be determined after verifying, through a test run, that the cleaning process does not affect the inductor's characteristics.

◆Cleaning conditions

- 1. The use of inappropriate solutions can cause foreign substances such as flux residue to adhere to the inductor, resulting in a degradation of the inductor's electrical properties (especially insulation resistance).
- 2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may detrimentally affect the performance of the inductors.

Technical (1) Excessive cleaning

a. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of the PC board which may lead to the cracking of the inductor or the soldered portion, or decrease the terminal electrodes' strength. Thus the following conditions should be carefully checked;

Ultrasonic output Below 20W/2
Ultrasonic frequency Below 40kHz
Ultrasonic washing period 5 min. or less

6. Post cleaning processes

◆Application of resin coatings, moldings, etc. to the PCB and components.

Precautions

- 1. With some type of resins a decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the inductor's performance.
- 2. When a resin's hardening temperature is higher than the inductor's operating temperature, the stresses generated by the excess heat may lead to inductor damage or destruction.
- 3. Stress caused by a resin's temperature generated expansion and contraction may damage inductors.

The use of such resins, molding materials etc. is not recommended.

7. Handling

- ◆Breakaway PC boards (splitting along perforations)
 - 1. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board.
 - 2. Board separation should not be done manually, but by using the appropriate devices.
- ◆General handling precautions
 - 1. Always wear static control bands to protect against ESD.
 - $\ensuremath{\mathbf{2}}.$ Keep the inductors away from all magnets and magnetic objects.
- Precautions

 3. Use non-magnetic tweezers when handling inductors.
 - 4. Any devices used with the inductors (soldering irons, measuring instruments) should be properly grounded.
 - 5. Keep bare hands and metal products (i.e., metal desk) away from chip electrodes or conductive areas that lead to chip electrodes.
 - 6. Keep inductors away from items that generate magnetic fields such as speakers or coils.
 - ◆Mechanical considerations
 - 1. Be careful not to subject the inductors to excessive mechanical shocks.
 - (1) If inductors are dropped on the floor or a hard surface they should not be used.
 - (2) When handling the mounted boards, be careful that the mounted components do not come in contact with or bump against other boards or components.

8. Storage conditions

◆Storage

1. To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible.

Precautions

Recommended conditions
Ambient temperature Below 30°C

Humidity Below 70% RH

The ambient temperature must be kept below 40°C. Even under ideal storage conditions inductor electrode solderability decreases as time passes, so inductors should be used within 6 months from the time of delivery.

*The packaging material should be kept where no chlorine or sulfur exists in the air.

◆Storage

Technical considerations

1. If the parts are stocked in a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. For this reason, components should be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the inductors.

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SMD COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES



REFLOW

■PARTS NUMBER

*Operating Temp. : -25~+105°C (Including self-generated heat)



△=Blank space

①Series name

Code	Series name
BU	Common mode choke coil

© D . . .

Code △01~△10

4)Product classification code

2)Dimensions of	core
Code	Dimensions of core[mm]
05	5.0

(5)Packaging		
Code	Packaging	
ΔΤ	Taping	

Product classification code

Product classification code

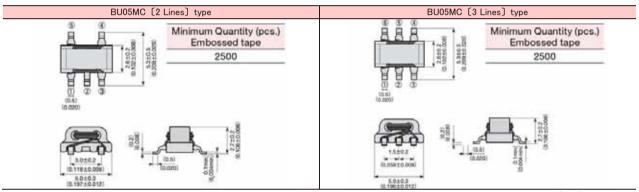
3Shape

© Giliap G	
Code	Shape
MC	Surface mount type

6Internal code

Code	Internal code
Δ	Standard

■STANDARD EXTERNAL DIMENSIONS / MINIMUM QUANTITY



Unit:mm(inch)

The values without tolerance are for reference only.

PARTS NUMBER

BU05MC type

Parts number	EHS	Number of lines	Impedance [Ω] (typ.)	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage [V] (D.C.)	Insulation resistance $[M\Omega]$ (min.)
BU05MC 01 T	RoHS	2	1000	60	0.12	1.0	50	100
BU05MC 08 T	RoHS	3	700	60	0.11	0.5	50	100

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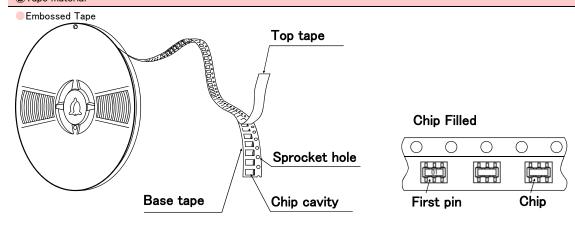
SMD COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES, BALUN TRANSFORMERS

■PACKAGING

1 Minimum Quantity

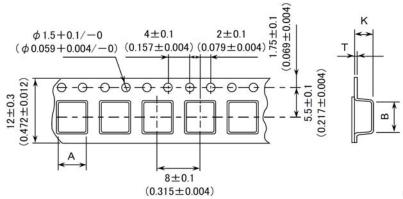
Type	Minimum Quantity [pcs]			
туре	Вох	Taping		
BU05MC	_	2500		
BU05MB	200	_		
BU06MB	150	ı		

②Tape material



3 Taping dimensions

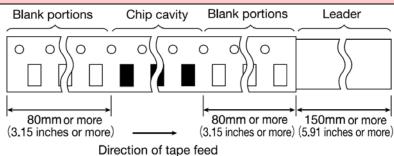
Embossed tape 12mm wide (0.472 inches wide)



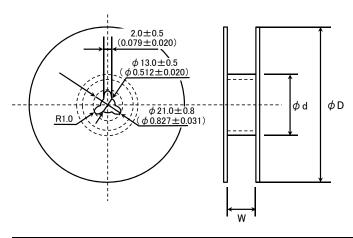
Unit:mm(inch)

Turna	Insertion	Chip	cavity	Tape thickness		
Type	pitch	Α	В	K	Т	
BU05MC	8.0±0.1	5.2±0.1	5.6±0.1	3.2±0.1	0.4±0.05	
BOOSING	(0.315 ± 0.004)	(0.205 ± 0.004)	(0.220 ± 0.004)	(0.126 ± 0.004)	(0.016 ± 0.002)	
					Unit:mm(inch)	

4 Leader and Blank portion



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Type	ϕ D	ϕ d	W	
BU05MC	330 ± 2.0	80±1.0	13.5±1.0	
BOOSINIC	(12.99 ± 0.079)	(3.15±0.039)	(0.53 ± 0.039)	

Unit:mm(inch)

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SMD COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES, BALUN TRANSFORMERS

■PRECAUTIONS

1. Circuit Design Operating environment 1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical Precautions equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance. 2. PCB Design Land pattern design Precautions 1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of specifications. ◆Land pattern design Surface Mounting Mounting and soldering conditions should be checked beforehand. · Applicable soldering process to these products is reflow soldering only. Recommended Land Patterns [BU05MC] Technical considerations Unit: mm 3. Considerations for automatic placement Adjustment of mounting machine Precautions 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. ◆Adjustment of mounting machine Technical 1. When installing products, care should be taken not to apply distortion stress as it may deform the products. considerations 4. Soldering ◆Reflow soldering 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. 2. This product can be used reflow soldering only. 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering Precautions heat, soldering etc sufficiently. Recommended conditions for using a soldering iron [BU05MC] · Put the soldering iron on the land-pattern. Soldering iron's temperature – Below 350°C Duration – 3 seconds or less The soldering iron should not directly touch the inductor. ◆Reflow soldering 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently Technical degrade the reliability of the products. considerations Recommended conditions for using a soldering iron If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products 5. Cleaning Cleaning conditions Precautions

1. Please contact any of our offices for a cleaning

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6. Handling ◆Handling 1. Keep the product away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations Precautions 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push onto an exposed part of ferrite cores. ◆Packing 1. Please avoid accumulation of a packing box as much as possible. 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards (splitting along perforations) 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆Mechanical considerations Technical 1. There is a case to be damaged by a mechanical shock. considerations 2. There is a case to be broken by the handling in transportation. ◆Pick-up pressure 1. An excessive shock or stress may cause a damage to the product or a deterioration of a characteristic. **♦**Packing 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

7. Storage condi	ions
Precautions	 ♦ Storage To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.

LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES



WAVE

■PARTS NUMBER

* Operating Temp.:-25~+105°C (Including self-generated heat)



 Δ =Blank space

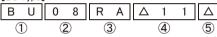
①Series name

Code	Series name		
TLF	Common mode choke coil		
②Dimensions of	core		
Code	Dimensions of core[mm]		
△9	9		
3Shape			
Code	Shape		
UB△	U core, vertically split wound		
UBH	U core, horizontally split wound		

4 Nominal inductance

Code (example)	Nominal inductance[μ H]	
302	3000	
203	20000	
⑤Inductance tole	erance	
Code	Inductance tolerance	
W	+100/-10%	
⑥Internal code		
Code	Internal code	
K1	Adhesive fixation	

[BU Type]



 Δ =Blank space

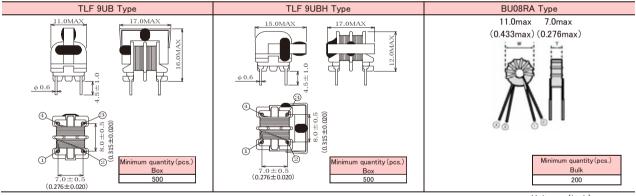
1)Series name

Series name					
Common mode choke coil					
core					
Dimensions of core[mm]					
8.0					
Shape					
Double-wire lead					

4 Product classification code

Product classification code
Product classification code
Internal code
Standard

■STANDARD EXTERNAL DIMENSIONS / MINIMUM QUANTITY



Unit:mm(inch)

PARTS NUMBER

Parts number	EHS	Number of lines	Nominal inductance [mH]	Inductance tolerance	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage [V] (D.C.)	Insulation resistance [MΩ] (min.)
TLF 9UBH302W K1	RoHS	2	3.0	+100/-10%	1.5	0.40	50	100
TLF 9UB 302W K1	RoHS	2	3.0	+100/-10%	1.5	0.40	50	100
TLF 9UBH802W K1	RoHS	2	8.0	+100/-10%	3.0	0.30	50	100
TLF 9UB 802W K1	RoHS	2	8.0	+100/-10%	3.0	0.30	50	100
TLF 9UBH203W K1	RoHS	2	20.0	+100/-10%	6.5	0.18	50	100
TLF 9UB 203W K1	RoHS	2	20.0	+100/-10%	6.5	0.18	50	100

Parts number	EHS	Number of lines	Nominal inductance [μ H]	Inductance Measuring frequency [kHz]	Impedance [Ω](typ.)	Impedance Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (D.C.)	Insulation resistance [MΩ] (min.)
BU08RA 11	RoHS	2	0.7~1.3	1	1000	250	0.013	4.0	50	100
BU08RA 16	RoHS	2	1.19~2.21	1	1200	200	0.011	3.0	50	100

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LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES LEADED COMMON MODE CHOKE COILS FOR AC LINES

■PACKAGING

1)Minimum Quantity			
BU Type			
Tura	Minimum Quantity[pcs]		
Туре	Вох	Bulk	
BU08RA□□	_	200	
TLH/TLF Type	Minimum Qua	antity[pcs]	
Туре	Вох		
TLH10UA□			
TLH10UB	1000		
TLF10UAH			
TLF9UA□			
	500		
TLF9UB□		500	
TLF9UB□ TLF14CB□	50	•	

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LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES, LEADED COMMON MODE CHOKE COILS FOR AC LINES

■ RELIABILITY DATA

1. Operating Tempe	erature Range			
	BU-RA Type			
Specified Value	TLH, TLF Type		−25~+ 105°C	
Test Method and Remarks	Including temperature rise due	to self-genera	ted heat.	
2. Storage tempera	ture range			
Specified Value	BU-RA Type		−40~+ 85°C	
· 	TLH, TLF Type			
0.0.1				
3. Rated current	I			
Specified Value	BU-RA Type		Within the specified range	
	TLH, TLF Type			
Test Method and			of AC current within the temperature rise of 60°C of AC current within the temperature rise of 45°C	
Remarks			of DC current within the temperature rise of 45°C	
	ı			
4. Inductance				
0 '6 1)/1	BU-RA Type		West of the Land	
Specified Value	TLH, TLF Type		Within the specified tolerance	
Test Method and Remarks	TLF9U: Measuring equipment: Measuring frequency: Measuring voltage: TLH, TLF(except TLF9U): Measuring equipment: Measuring frequency:	1kHz 1Vrms LCR meter 428- 1kHz	4A or its equivalent 4A or its equivalent	
	Measuring voltage :	0.1Vrms		
5. DC resistance				
0 10 101	BU-RA Type		Medical and a second a second and a second a	
Specified Value	TLH, TLF Type		Within the specified tolerance	
Test Method and Remarks	d Measuring equipment : DC ohmmeter			
6. Terminal strengtl	h tensile force			
Specified Value	BU-RA Type		No abnormality	
Spoomod value	TLH, TLF Type		acdity	
Test Method and		•	ly in the direction to draw terminal 5N、10±1sec. d tensile force gradually in the direction to draw terminal.	
Remarks	TLH10UAH, TLF (except TLF9U): Apply the stated tensile force gradually in the direction to draw terminal.			
	force [N]	duration [s]	2002 College C	
	10	30±5		

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7. Insulation resista	nce between wires			
Specified Value	BU-RA Type		100110	
Specified Value	TLH, TLF Type		100M Ω min.	
Test Method and Remarks	Applied voltage : 50VDC (BU-RA,) : 500VDC (TLH, TLF (e : 250VDC (TLF9UB) Duration : 60sec.		cept TLF9UB))	
8. Insulation resista	ance between wire and c	ore		
	BU-RA Type			
Specified Value	TLH, TLF Type		100MΩ min.(except TLH, TLF10UAH Type)	
Test Method and Remarks	:	500VDC (TLF (except 250VDC (TLF9UB)	TLF9UB))	
	Duration :	60 sec.		
0 Withotonding the	twoon wires			
9. Withstanding : be	BU-RA Type	1		
Specified Value			No abnormality	
	TLH, TLF Type	250VDC (BU-RA)		
Test Method and Remarks				
	•			
10. Withstanding : b	etween wires and core			
	BU-RA Type			
Specified Value	TLH, TLF Type		No abnormality(except TLH, TLF10UAH Type)	
Test Method and Remarks		2000VAC (TLF (except 500VDC (TLF9UB)	: TLF9UB))	
	Duration :	60sec.		
11. Rated voltage	T			
Specified Value	BU-RA Type		Within the specified range	
•	TLH, TLF Type			
Test Method and Remarks	TLH, TLF (except TLF BU-RA,TLF9UB	F9UB) : 250VAC : 50VDC		
12. Resistance to v	ibration			
12. Resistance to v	BU-RA Type		Appearance : No abnormality Inductance change : Within ±15%	
	TLH, TLF Type		TLF9U : Inductance change : Within ±5% TLH, TLF (except TLF9U) : Appearance is no abnormality and within the specified range	
Test Method and Remarks	BU-RA,TLH, TLF : Ac Direction Frequency range Amplitude Mounting method Recovery	: 2hrs each in X, Y a : 10 to 55 to 10Hz (: 1.5mm (shall not e) : soldering onto PC	xceed acceleration 196m/s²)	

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13. Solderability			
Specified Value	BU-RA Type		At least 75% of terminal electrode is covered by new solder.
Specified Value	TLH, TLF Type		At least 90% of terminal electrode is covered by new solder.
Test Method and Remarks	TLH, TLF: Solder temperature Duration Immersion depth TLH, TLF: Solder temperature Duration	: 235±0.5°C : 2±0.5sec. : Up to 1.5 to 2.0mn : 245±5°C : 4±1sec.	n from PBC mounted level.
	Immersion depth	: Up to 1.0 to 1.5mm from PBC mounted level.	

14. Resistance to soldering heat				
Specified Value	BU-RA Type		Appearance : No abnormality Inductance change : Within ±15%	
	TLH, TLF Type		TLF9UA : Inductance change : Within ±5% TLF14CB : Appearance is no abnormality and within the specified range	
Test Method and Remarks	TLH, TLF: Solder temperature Duration Immersion depth Recovery TLH, TLF:	Solder temperature : 260±5°C Ouration : 5±0.5sec. Inmersion depth : Up to 1.5 to 2.0mm from PBC mounted level. Recovery : At least 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs.		
nemans	Solder temperature Duration Immersion depth Recovery	•	n from PBC mounted level. covery under the standard condition after the removal from test chamber, followed by the thin 2hrs.	

15. Thermal shock	i. Thermal shock		
Specified Value	BU-RA Type	Appearance : No abnormality Inductance change : Within ±15%	
	TLH, TLF Type	TLF9UA : Inductance change : Within ±15% TLH, TLF (except TLF9UA) : Withstanding voltage : No abnormality Insulation resistance : No abnormality	
Test Method and Remarks	BU-RA,TLH, TLF: According to JIS C 0025 Conditions for 1 cycle -25°C~+85°C, keep each 30min Number of cycles : 10 Recovery : At least 1hr of recover measurement within 2	ery under the standard condition after the removal from test chamber, followed by the 2 hrs.	

16. Damp heat				
	BU-RA Type			
Specified Value	TLH, TLF Type		TLF9UA : Inductance change : Within ±15% TLH, TLF (except TLF9UA) : Withstanding voltage : No abnormality Insulation resistance : No abnormality	
Test Method and Remarks	Humidity Duration	: 60±2°C : 40±2°C (※except TLF9U : 90~95%RH : 500 hrs : At least 1hr of recovery un	der the standard removal from test chamber followed by the measurement within 2 hrs.	

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17. Loading under damp heat			
0 :5 1)/1	BU-RA Type		Appearance : No abnormality Inductance change : Within ±15%
Specified Value	TLH, TLF Type		Withstanding voltage : No abnormality Insulation resistance : No abnormality
	BU-RA: Temperature Humidity Applied current Recovery		urrent across windings (※except TLF9U) ry under the standard removal from test chamber followed by the measurement within 2 hrs.
Test Method and Remarks	TLH, TLF : Temperature Humidity Duration	: 60±2°C : 40±2°C (※except TI : 90~95%RH : 100 hrs	LF9U) urrent across windings (※except TLF9U)
	Applied voltage	TLF9UA 25 TLF9UB 50	ecified voltage between windings. 50VAC DVDC ry under the standard removal from test chamber followed by the measurement within 2 hrs.

18. Low temperatur	re life test	
Specified Value	BU-RA Type	Appearance : No abnormality Inductance change : Within ±15%
	TLH, TLF Type	TLF9U : Inductance change : Within ±15% TLH, TLF (except TLF9U) : Withstanding voltage : No abnormality Insulation resistance : No abnormality
Test Method and Remarks	BU-RA,TLH, TLF: Temperature : -25±2°C	

19. High Temperature life test			
	BU-RA Type		Appearance : No abnormality Inductance change : Within ±15%
Specified Value	TLH, TLF Type		TLF9U : Inductance change : Within $\pm 15\%$ TLH, TLF (except TLF9U) : Withstanding voltage : No abnormality Insulation resistance : No abnormality
Test Method and Remarks	BU-RA,TLH, TL F: Temperature : 85±2°C (※ BU-RA) : 105±3°C (※ TLF·TLH) Duration : 500 hrs Recovery : At least 1hr of recovery under the standard removal from test chamber followed by the measurement within 2 hrs.		

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LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES, LEADED COMMON MODE CHOKE COILS FOR AC LINES

■PRECAUTIONS

1. Circuit Design Operating environment 1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical Precautions equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance. 2. PCB Design Design Precautions 1. Please design insertion pitches as matching to that of leads of the component on PCBs. ◆Design Technical 1. When Inductors are mounted onto a PC board, hole dimensions on the board should match the lead pitch of the component, if not, it will considerations cause breakage of the terminals or cracking of terminal roots covered with resin as excess stress travels through the terminal legs. 3. Soldering ◆Wave soldering 1. Please refer to the specifications in the catalog for a wave soldering. 2. Do not immerse the entire inductor in the flux during the soldering operation. Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming of adhesion, temperature of resistance to Precautions soldering heat, etc. sufficiently. Recommended conditions for using a soldering iron Put the soldering iron on the land-pattern. Soldering iron's temperature – Below 350°C Duration – 3 seconds or less · The soldering iron should not directly touch the product. ◆Lead free soldering 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently Technical degrade the reliability of the products. considerations ◆Recommended conditions for using a soldering iron If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. 4. Cleaning ◆Cleaning conditions Precautions 1. TLF type Please contact any of our offices for about a cleaning. 5. Handling Handling 1. Keep the product away from all magnets and magnetic objects. Mechanical considerations 1. Please do not give the product any excessive mechanical shocks. 2. TLF type Precautions Please do not add any shock or power to a product in transportation. 1. Please do not give the product any excessive mechanical shocks. In loading, please pay attention to handling indication mentioned in a packing box (a loading direction / number of maximum loading / ◆Handling 1. There is a case that a characteristic varies with magnetic influence. Mechanical considerations Technical 1. There is a case to be damaged by a mechanical shock. considerations 2. TLF type There is a case to be broken by a fall. **◆**Packing

1. There is a case that a lead route turns at by a fall or an excessive shock.

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6. Storage conditions ◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions Ambient temperature : 0~40°C Precautions Humidity: Below 70% RH The ambient temperature must be kept below 30°C. Even under ideal storage conditions, the solderbility of electrodes decreases gradually, so the products should be mounted within one year from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage. **♦**Storage Technical 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes considerations and deterioration of taping/packaging materials may take place.

LEADED COMMON MODE CHOKE COILS FOR AC LINES





■PARTS NUMBER

*Operating Temp. : -25~+105°C (Including self-generated heat)











①Series name

Code	Series name
TLF	Common mode choke
TLH	Hybrid choke

a			
2)Dim	ensions	of core	

92				
Code	Dimensions of core[mm]			
Δ9	9			
10	10			
14	14			
24	24			

(3)S	I	
.S/S	na	рe

<u> </u>	
Code	Shape
UA△	U core, vertical type
UAH	U core, horizontal type
UB△	U core, vertically split wound
CB△	Square type core vertically split wound
CBH	Square type core horizontally split wound
НВ△	Double-square type core vertically split wound
HBH	Double-square type core horizontally split
пвп	wound

4 Nominal Inductance

1

Code (example)	Nominal Inductance[μ H]
102	1000
103	10000

⑤Inductance tolerance

Code	Inductance tolerance			
Δ	Nominal Values or higher			
W	+100/-10%			

6Rated current

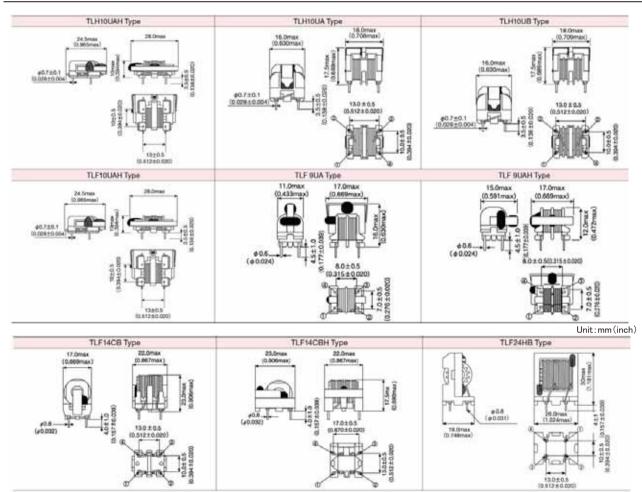
Code	Rated current[A]
R54	0.54
0R8	0.8

*R=Decimal point

7Internal code

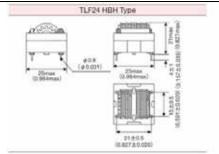
Code	Internal code
K1	Adhesive fixation

STANDARD EXTERNAL DIMENSIONS / MINIMUM QUANTITY



Unit:mm(inch)

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Type	Minimum Quantity (pcs.) Box		
TLH Type	500		
TLF Type	500		

Unit:mm(inch)

■PARTS NUMBER

TLH10UAH type (Hybrid choke)

Parts number		Common mode inductance [mH]	Inductance tolerance	Normal mode inductance [mH] (typ.)	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)
TLH10UAH872 0R7	RoHS	8.7	min.	0.70	1.00	0.7	250
TLH10UAH992 0R6	RoHS	9.9	min.	0.85	1.35	0.6	250
TLH10UAH123 0R5	RoHS	12	min.	1.06	1.60	0.5	250

TLH10UA type (Hybrid choke)

Parts number	EHS	Common mode inductance [mH]	Inductance tolerance	Normal mode inductance [mH] (typ.)	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)
TLH10UA 901 2R0	RoHS	0.9	min.	0.067	0.089	2.0	250
TLH10UA 112 1R8	RoHS	1.1	min.	0.087	0.126	1.8	250
TLH10UA 152 1R6	RoHS	1.5	min.	0.126	0.171	1.6	250
TLH10UA 212 1R4	RoHS	2.1	min.	0.160	0.222	1.4	250
TLH10UA 282 1R2	RoHS	2.8	min.	0.215	0.272	1.2	250
TLH10UA 432 1R0	RoHS	4.3	min.	0.330	0.398	1.0	250
TLH10UA 622 0R8	RoHS	6.2	min.	0.430	0.578	0.8	250
TLH10UA 872 0R7	RoHS	8.7	min.	0.644	0.878	0.7	250
TLH10UA 992 0R6	RoHS	9.9	min.	0.836	1.138	0.6	250
TLH10UA 143 0R5	RoHS	14	min.	1.256	1.567	0.5	250

TLH10UB type (Hybrid choke)

TETHOOD type (Hybrid chicke)								
Parts number	EHS	Common mode inductance [mH]	Inductance tolerance	Normal mode inductance [mH] (typ.)	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)	
TLH10UB 701 2R0	R₀HS	0.7	min.	0.056	0.097	2.0	250	
TLH10UB 112 1R7	RoHS	1.1	min.	0.068	0.133	1.7	250	
TLH10UB 142 1R4	RoHS	1.4	min.	0.113	0.214	1.4	250	
TLH10UB 232 1R2	RoHS	2.3	min.	0.150	0.274	1.2	250	
TLH10UB 352 1R0	RoHS	3.5	min.	0.232	0.422	1.0	250	
TLH10UB 442 0R8	RoHS	4.4	min.	0.328	0.624	0.8	250	
TLH10UB 872 0R7	RoHS	8.7	min.	0.580	0.982	0.7	250	
TLH10UB 972 0R6	RoHS	9.7	min.	0.735	1.314	0.6	250	
TLH10UB 113 0R5	R₀HS	11	min.	0.877	1.577	0.5	250	

TLF10UAH type

Parts number	EHS	Common mode inductance [mH]	Inductance tolerance	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)
TLF10UAH872 0R7	RoHS	8.7	min.	1.00	0.7	250
TLF10UAH992 0R6	RoHS	9.9	min.	1.35	0.6	250
TLF10UAH123 0R5	RoHS	12	min.	1.60	0.5	250

TLF 9UA type

Parts number	EHS	Common mode inductance [mH]	Inductance tolerance	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)
TLF 9UA 102W0R8K1	RoHS	1.0	+100/-10%	0.5	0.80	250
TLF 9UA 202WR54K1	RoHS	2.0	+100/-10%	1.0	0.54	250
TLF 9UA 302WR42K1	RoHS	3.0	+100/-10%	1.5	0.42	250
TLF 9UA 502WR32K1	RoHS	5.0	+100/-10%	2.5	0.32	250
TLF 9UA 802WR25K1	RoHS	8.0	+100/-10%	4.0	0.25	250
TLF 9UA 103WR23K1	RoHS	10	+100/-10%	4.5	0.23	250

TLF 9UAH type

Parts number	EHS	Common mode inductance [mH]	Inductance tolerance	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)
TLF 9UAH102W0R8K1	RoHS	1.0	+100/-10%	0.5	0.80	250
TLF 9UAH202WR54K1	RoHS	2.0	+100/-10%	1.0	0.54	250
TLF 9UAH302WR42K1	RoHS	3.0	+100/-10%	1.5	0.42	250
TLF 9UAH502WR32K1	RoHS	5.0	+100/-10%	2.5	0.32	250
TLF 9UAH802WR25K1	RoHS	8.0	+100/-10%	4.0	0.25	250
TLF 9UAH103WR23K1	RoHS	10	+100/-10%	4.5	0.23	250

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●TLF14CB type

Parts number	EHS	Common mode inductance [mH]	Inductance tolerance	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)
TLF14CB 102 1R5K1	RoHS	1.0	min.	0.10	1.5	250
TLF14CB 222 1R2K1	RoHS	2.2	min.	0.18	1.2	250
TLF14CB 332 1R0K1	RoHS	3.3	min.	0.32	1.0	250
TLF14CB 472 1R0K1	RoHS	4.7	min.	0.38	1.0	250
TLF14CB 562 0R8K1	RoHS	5.6	min.	0.42	0.8	250
TLF14CB 682 0R8K1	RoHS	6.8	min.	0.60	0.8	250
TLF14CB 103 0R7K1	RoHS	10	min.	0.85	0.7	250
TLF14CB 223 0R4K1	RoHS	22	min.	1.7	0.4	250
TLF14CB 333 0R3K1	RoHS	33	min.	2.7	0.3	250
TLF14CB 473 0R2K1	R ₀ HS	47	min.	3.6	0.2	250
TLF14CB 563 0R2K1	RoHS	56	min.	5.0	0.2	250
TLF14CB 683 0R2K1	RoHS	68	min.	6.5	0.2	250

●TLF14CBH type

Parts number	EHS	Common mode inductance [mH]	Inductance tolerance	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)
TLF14CBH102 1R5K1	RoHS	1.0	min.	0.10	1.5	250
TLF14CBH222 1R2K1	RoHS	2.2	min.	0.18	1.2	250
TLF14CBH332 1R0K1	RoHS	3.3	min.	0.32	1.0	250
TLF14CBH472 1R0K1	RoHS	4.7	min.	0.38	1.0	250
TLF14CBH562 0R8K1	RoHS	5.6	min.	0.42	0.8	250
TLF14CBH682 0R8K1	RoHS	6.8	min.	0.60	0.8	250
TLF14CBH103 0R7K1	RoHS	10	min.	0.85	0.7	250
TLF14CBH223 0R4K1	RoHS	22	min.	1.7	0.4	250
TLF14CBH333 0R3K1	RoHS	33	min.	2.7	0.3	250
TLF14CBH473 0R2K1	RoHS	47	min.	3.6	0.2	250
TLF14CBH563 0R2K1	RoHS	56	min.	5.0	0.2	250
TLF14CBH683 0R2K1	RoHS	68	min.	6.5	0.2	250

TLF24HB type

Parts number	EHS	Common mode inductance [mH]	Inductance tolerance	DC Resistance [Ω](max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)
TLF24HB 122 3R0K1	RoHS	1.2	min.	0.045	3.0	250
TLF24HB 222 2R2K1	RoHS	2.2	min.	0.080	2.2	250
TLF24HB 272 2R0K1	RoHS	2.7	min.	0.090	2.0	250
TLF24HB 332 1R8K1	RoHS	3.3	min.	0.120	1.8	250
TLF24HB 392 1R5K1	RoHS	3.9	min.	0.130	1.5	250
TLF24HB 562 1R4K1	RoHS	5.6	min.	0.187	1.4	250
TLF24HB 682 1R2K1	RoHS	6.8	min.	0.254	1.2	250
TLF24HB 822 1R0K1	RoHS	8.2	min.	0.275	1.0	250
TLF24HB 103 1R0K1	RoHS	10	min.	0.345	1.0	250
TLF24HB 123 0R9K1	RoHS	12	min.	0.350	0.9	250
TLF24HB 183 0R8K1	RoHS	18	min.	0.550	0.8	250
TLF24HB 273 0R6K1	R₀HS	27	min.	0.880	0.6	250
TLF24HB 333 0R5K1	R ₀ HS	33	min.	1.150	0.5	250

TLF24HBH type

Parts number	EHS	Common mode inductance [mH]	Inductance tolerance	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage AC [V] (max.)
TLF24HBH122 3R0K1	RoHS	1.2	min.	0.045	3.0	250
TLF24HBH222 2R2K1	RoHS	2.2	min.	0.080	2.2	250
TLF24HBH272 2R0K1	R ₀ HS	2.7	min.	0.090	2.0	250
TLF24HBH332 1R8K1	R ₀ HS	3.3	min.	0.120	1.8	250
TLF24HBH392 1R5K1	R ₀ HS	3.9	min.	0.130	1.5	250
TLF24HBH562 1R4K1	R ₀ HS	5.6	min.	0.187	1.4	250
TLF24HBH682 1R2K1	RoHS	6.8	min.	0.254	1.2	250
TLF24HBH822 1R0K1	R ₀ HS	8.2	min.	0.275	1.0	250
TLF24HBH103 1R0K1	R ₀ HS	10	min.	0.345	1.0	250
TLF24HBH123 0R9K1	R ₀ HS	12	min.	0.350	0.9	250
TLF24HBH183 0R8K1	RoHS	18	min.	0.550	0.8	250
TLF24HBH273 0R6K1	R ₀ HS	27	min.	0.880	0.6	250
TLF24HBH333 0R5K1	RoHS	33	min.	1.150	0.5	250

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LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES LEADED COMMON MODE CHOKE COILS FOR AC LINES

■PACKAGING

1 Minimum Quantity			
BU Type			
Turna	Minimum Qua	antity[pcs]	
Туре	Вох	Bulk	
BU08RA□□	_	200	
TLH/TLF Type	Minimum Qua	antity[pcs]	
Туре	Box		
TLH10UA□			
TLH10UB	100	00	
TLF10UAH			
TLF9UA□		•	
	500		
TLF9UB□			
TLF9UB□ TLF14CB□	50	•	

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LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES, LEADED COMMON MODE CHOKE COILS FOR AC LINES

■ RELIABILITY DATA

1. Operating Tempe	erature Range						
	BU-RA Type						
Specified Value	TLH, TLF Type		−25~+ 105°C				
Test Method and Remarks	Including temperature rise due	Including temperature rise due to self—generated heat.					
2. Storage tempera	ture range						
Specified Value	BU-RA Type		−40~+ 85°C				
· 	TLH, TLF Type						
0.0.1							
3. Rated current	I						
Specified Value	BU-RA Type		Within the specified range				
	TLH, TLF Type						
Test Method and			of AC current within the temperature rise of 60°C of AC current within the temperature rise of 45°C				
Remarks			of DC current within the temperature rise of 45°C				
	ı						
4. Inductance							
0 '6 1)/1	BU-RA Type		West of the Land				
Specified Value	TLH, TLF Type		Within the specified tolerance				
Test Method and Remarks	TLF9U: Measuring equipment: Measuring frequency: Measuring voltage: TLH, TLF(except TLF9U): Measuring equipment: Measuring frequency:	1kHz 1Vrms LCR meter 428- 1kHz	4A or its equivalent 4A or its equivalent				
	Measuring voltage :	0.1Vrms					
5. DC resistance							
0 10 101	BU-RA Type		Medical and a second a second and a second a				
Specified Value	TLH, TLF Type		Within the specified tolerance				
Test Method and Remarks	Measuring equipment :	DC ohmmeter					
6. Terminal strengtl	h tensile force						
Specified Value	BU-RA Type		No abnormality				
Spoomod value	TLH, TLF Type		acdity				
Test Method and		•	ly in the direction to draw terminal 5N、10±1sec. d tensile force gradually in the direction to draw terminal.				
Remarks	TI H10UAH, TI F (except TI F9	U): Apply the st	ated tensile force gradually in the direction to draw terminal.				
	force [N]	duration [s]	2002 College C				
	10	30±5					

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7. Insulation resista	nce between wires		
Specified Value	BU-RA Type		100M Ω min.
Specified Value	TLH, TLF Type		TOOM SZ MIN.
Test Method and Remarks	Applied voltage : 50VDC (BU-RA,) : 500VDC (TLH, TLF (: 250VDC (TLF9UB) Duration : 60sec.		cept TLF9UB))
8. Insulation resista	ance between wire and c	ore	
	BU-RA Type		
Specified Value	TLH, TLF Type		100MΩ min.(except TLH, TLF10UAH Type)
Test Method and Remarks	:	500VDC (TLF (except 250VDC (TLF9UB)	TLF9UB))
	Duration :	60 sec.	
0 Withotonding the	twoon wires		
9. Withstanding : be	BU-RA Type	1	
Specified Value			No abnormality
	TLH, TLF Type	250VDC (BU-RA)	
Test Method and Remarks	:	2000VAC (TLH, TLF (e 500VDC (TLF9UB) 60sec	xcept TLF9UB))
	•		
10. Withstanding : b	etween wires and core		
	BU-RA Type		
Specified Value	TLH, TLF Type		No abnormality(except TLH, TLF10UAH Type)
Test Method and Remarks		2000VAC (TLF (except 500VDC (TLF9UB)	: TLF9UB))
	Duration :	60sec.	
11. Rated voltage	T		
Specified Value	BU-RA Type		Within the specified range
•	TLH, TLF Type		
Test Method and Remarks	TLH, TLF (except TLF BU-RA,TLF9UB	F9UB) : 250VAC : 50VDC	
12. Resistance to v	ibration		
	BU-RA Type		Appearance : No abnormality Inductance change : Within ±15%
Specified Value	TLH, TLF Type		TLF9U : Inductance change : Within ±5% TLH, TLF (except TLF9U) : Appearance is no abnormality and within the specified range
Test Method and Remarks	BU-RA,TLH, TLF : Ac Direction Frequency range Amplitude Mounting method Recovery	: 2hrs each in X, Y a : 10 to 55 to 10Hz (: 1.5mm (shall not e) : soldering onto PC	xceed acceleration 196m/s²)

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13. Solderability			
Specified Value	BU-RA Type		At least 75% of terminal electrode is covered by new solder.
Specified Value	TLH, TLF Type		At least 90% of terminal electrode is covered by new solder.
Test Method and Remarks	TLH, TLF: Solder temperature Duration Immersion depth TLH, TLF: Solder temperature Duration	: 235±0.5°C : 2±0.5sec. : Up to 1.5 to 2.0mn : 245±5°C : 4±1sec.	n from PBC mounted level.
	Immersion depth	: Up to 1.0 to 1.5mm	n from PBC mounted level.

14. Resistance to s	14. Resistance to soldering heat				
Specified Value	BU-RA Type		Appearance : No abnormality Inductance change : Within ±15%		
	TLH, TLF Type		TLF9UA : Inductance change : Within ±5% TLF14CB : Appearance is no abnormality and within the specified range		
Test Method and Remarks	Recovery : At least 1hr of remeasurement with		n from PBC mounted level. covery under the standard condition after the removal from test chamber, followed by the thin 2hrs.		
nemans	TLH, TLF : Solder temperature Duration Immersion depth Recovery	•	n from PBC mounted level. covery under the standard condition after the removal from test chamber, followed by the thin 2hrs.		

15. Thermal shock	15. Thermal shock					
Specified Value	BU-RA Type	Appearance : No abnormality Inductance change : Within ±15%				
	TLH, TLF Type	TLF9UA : Inductance change : Within ±15% TLH, TLF (except TLF9UA) : Withstanding voltage : No abnormality Insulation resistance : No abnormality				
Test Method and Remarks	BU-RA,TLH, TLF: According to JIS C 0025 Conditions for 1 cycle -25°C~+85°C, keep each 30min Number of cycles :10 Recovery : At least 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2 hrs.					

16. Damp heat				
	BU-RA Type			
Specified Value	TLH, TLF Type		TLF9UA : Inductance change : Within ±15% TLH, TLF (except TLF9UA) : Withstanding voltage : No abnormality Insulation resistance : No abnormality	
Test Method and Remarks	Humidity Duration	: 60±2°C : 40±2°C (※except TLF9U : 90~95%RH : 500 hrs : At least 1hr of recovery un	der the standard removal from test chamber followed by the measurement within 2 hrs.	

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17. Loading under o	lamp heat			
Specified Value	BU-RA Type		Appearance : No abnormality Inductance change : Within ±15%	
	TLH, TLF Type		Withstanding voltage: No abnormality Insulation resistance: No abnormality	
	BU-RA: Temperature Humidity Applied current Recovery		urrent across windings (※except TLF9U) ry under the standard removal from test chamber followed by the measurement within 2 hrs.	
Test Method and Remarks	TLH, TLF: Temperature Humidity Duration Applied voltage	: 60±2°C : 40±2°C (※except TLF9U) : 90~95%RH : 100 hrs : 500 hrs Apply rated current across windings (※except TLF9U) : Apply the following specified voltage between windings.		
	Recovery	TLF9UB 50	OVAC OVDC ry under the standard removal from test chamber followed by the measurement within 2 hrs.	

18. Low temperature life test					
Specified Value	BU-RA Type	Appearance : No abnormality Inductance change : Within ±15%			
	TLH, TLF Type	TLF9U : Inductance change : Within ±15% TLH, TLF (except TLF9U) : Withstanding voltage : No abnormality Insulation resistance : No abnormality			
Test Method and Remarks	Duration : 500 hrs	Temperature : -25±2°C : -40±2°C (※ BU-RA·TLF·TLH) Ouration : 500 hrs			

Specified Value	BU-RA Type		Appearance : No abnormality
			Inductance change : Within ±15%
	TLH, TLF Type		TLF9U : Inductance change : Within ±15%
			TLH, TLF (except TLF9U) : Withstanding voltage : No abnormality
			Insulation resistance : No abnormality
Test Method and Remarks	BU-RA,TLH, TL F :		
	Temperature	:85±2°C (※ BU-RA)	
		: 105±3°C (※ TLF•TLH)	
	Duration	: 500 hrs	
	Recovery	: At least 1hr of recovery ur	nder the standard removal from test chamber followed by the measurement within 2 hrs.

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LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES, LEADED COMMON MODE CHOKE COILS FOR AC LINES

■PRECAUTIONS

1. Circuit Design Operating environment 1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical Precautions equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance. 2. PCB Design Design Precautions 1. Please design insertion pitches as matching to that of leads of the component on PCBs. ◆Design Technical 1. When Inductors are mounted onto a PC board, hole dimensions on the board should match the lead pitch of the component, if not, it will considerations cause breakage of the terminals or cracking of terminal roots covered with resin as excess stress travels through the terminal legs. 3. Soldering ◆Wave soldering 1. Please refer to the specifications in the catalog for a wave soldering. 2. Do not immerse the entire inductor in the flux during the soldering operation. Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming of adhesion, temperature of resistance to Precautions soldering heat, etc. sufficiently. Recommended conditions for using a soldering iron Put the soldering iron on the land-pattern. Soldering iron's temperature – Below 350°C Duration – 3 seconds or less · The soldering iron should not directly touch the product. ◆Lead free soldering 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently Technical degrade the reliability of the products. considerations ◆Recommended conditions for using a soldering iron If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. 4. Cleaning ◆Cleaning conditions Precautions 1. TLF type Please contact any of our offices for about a cleaning. 5. Handling Handling 1. Keep the product away from all magnets and magnetic objects. Mechanical considerations 1. Please do not give the product any excessive mechanical shocks. 2. TLF type Precautions Please do not add any shock or power to a product in transportation. 1. Please do not give the product any excessive mechanical shocks. In loading, please pay attention to handling indication mentioned in a packing box (a loading direction / number of maximum loading / ◆Handling 1. There is a case that a characteristic varies with magnetic influence. Mechanical considerations Technical 1. There is a case to be damaged by a mechanical shock. considerations 2. TLF type There is a case to be broken by a fall. **◆**Packing

1. There is a case that a lead route turns at by a fall or an excessive shock.

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6. Storage conditions ◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions Ambient temperature : 0~40°C Precautions Humidity: Below 70% RH The ambient temperature must be kept below 30°C. Even under ideal storage conditions, the solderbility of electrodes decreases gradually, so the products should be mounted within one year from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage. **♦**Storage Technical 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes considerations and deterioration of taping/packaging materials may take place.